



Technical challenges for the new T2K High Angle TPCs

19 July 2024

Stefano Levorato

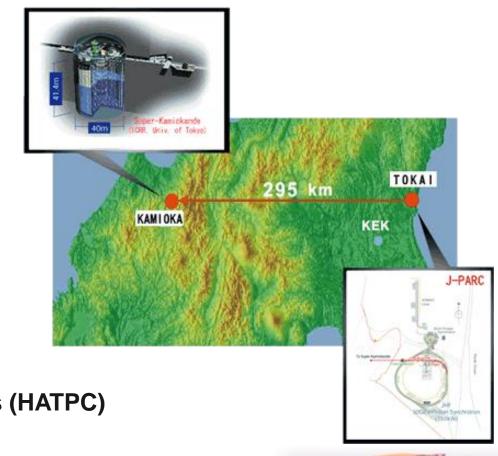
on behalf of the T2K ND280 upgrade group

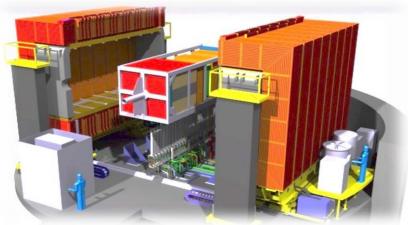




Outlook

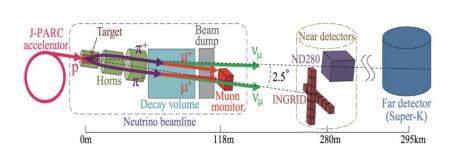
- The T2K ND280 experiment
- The ND280 upgrade project
 - The motivations
 - The upgrade
- The High Angle Time Projection Chambers (HATPC)
 - Mechanical constrains
 - Electrical constrain and performance
- The Encapsulated Resistive Anode Micromegas (ERAM)
 - Construction
 - Quality assessment
- Conclusions

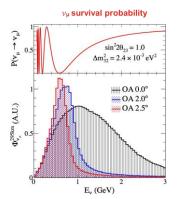




The T2K experiment and the role of ND280

High intensity ~0.6 GeV ν_{μ} beam produced at J-PARC (Tokai) $\rightarrow \nu$ or $\bar{\nu}$ mode by changing the horn polarity





Neutrinos detected at the <u>Near Detector (ND280)</u> and at the Far Detector (Super-Kamiokande)

- ν_{e} and $\bar{\nu_{e}}$ appearance \rightarrow determine θ_{13} and δ_{CP}
- Precise measurement of ν_{μ} disappearance $\rightarrow \theta_{23}$ and $|\Delta m^2_{32}|$

Near Detector complex at 280 meters from the target Off-Axis ND280 Constraint systematics in T2K oscillation analyses In operation since 2010 and upgraded in 2023 WAGASCI/BabyMIND Installed in 2019 Cross-sections on water INGRID: on-axis detector Monitoring ν beam profile day-by-day Cross-section measurements E_v~2.2 GeV In operation since 2009

Several detectors installed to monitor the beam§ reduce systematic uncertainties in oscillation analyses, and measure ν and $\bar{\nu}$ cross-sections

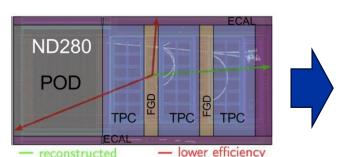
ND to measure un-oscillated beam flux and v cross sections

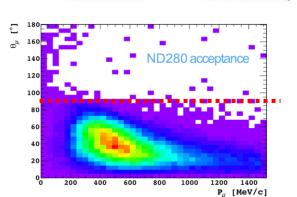


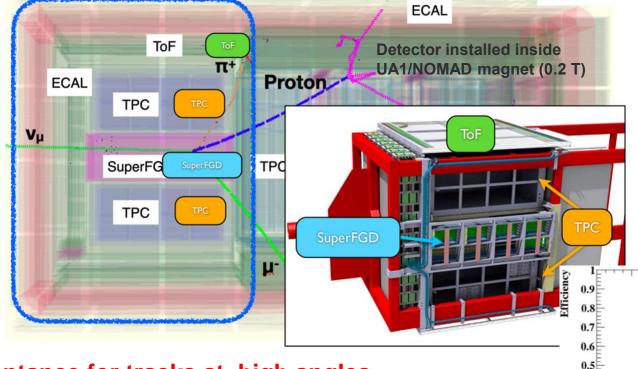


The ND280 experiment: the upgrade

- Reduced angular acceptance ν events, mostly reconstruct forward going tracks entering the TPCs
- Low efficiency to reconstruct low momenta protons







New detectors to extend acceptance for tracks at high angles





17.07.2023

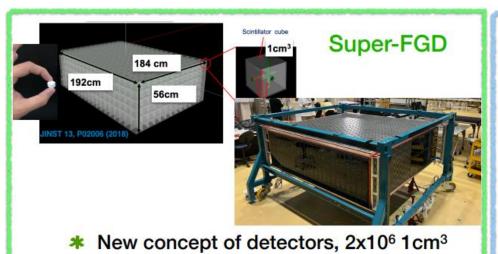
Proton tracking threshold

Work In Progress

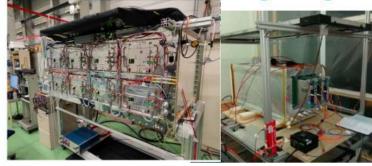
Muons in TPC or

stopping in SuperFGD

ND280: the upgrade detectors







New TPCs instrumented with Encapsulated Resistive Anode MicroMegas (ERAM)



cubes

***** Each cube is read by 3 WLS → 3D view

TOF

6 TOF planes to reconstruct track direction Time resolution ~150 ps

6





17.07.2023

ND280: installations at J-PARC

TOF installation (July 2023)

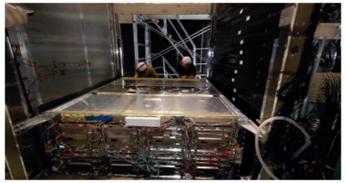




17.07.2023

Bottom TPC installation (September 2023)





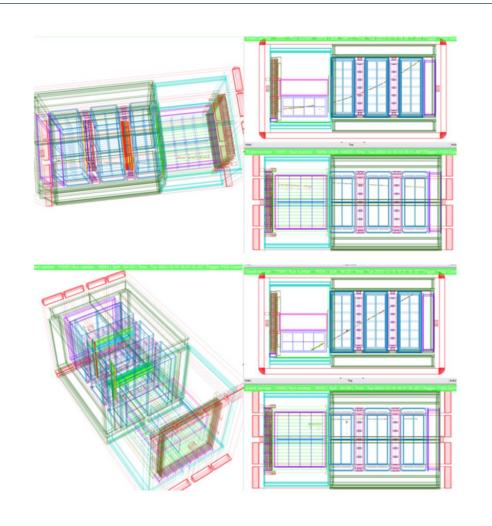
Super-FGD installation (October 2023)

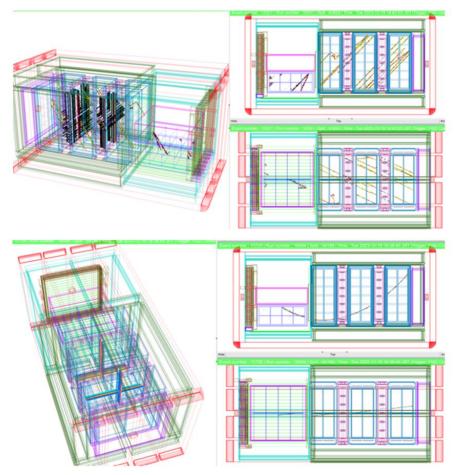






N280: commissioning at JPARC with cosmics





- Detector commissioning with and without magnetic field
- Alignment runs
- New software deployment
- New T2K gas system commissioning for both vertical and horizontal TPCs



N280: v technical runs in December 2023 and

February 2024 physics run







17.07.2023

ND280: upgrade completed! Top-HATPC installed in the end of April 2024

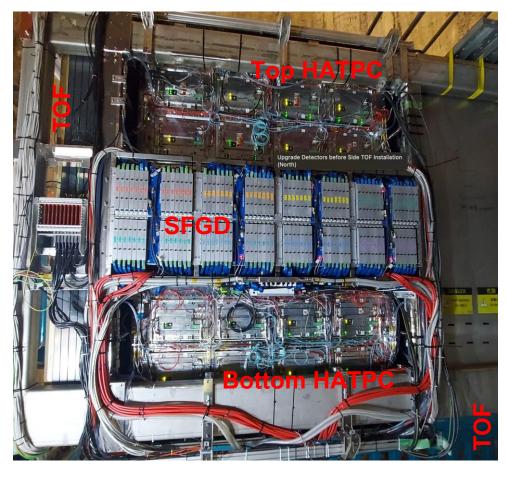










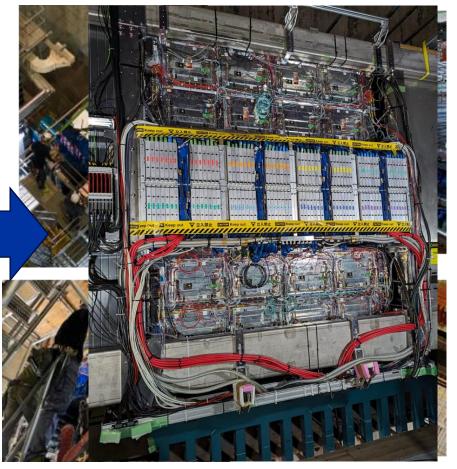


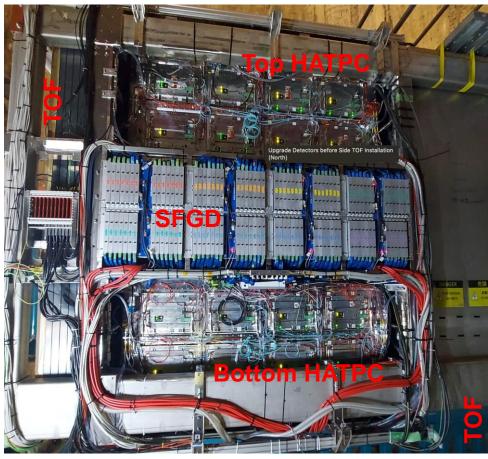




ND280: upgrade completed! Top-HATPC installed in the end of April 2024



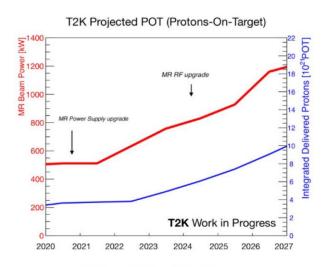


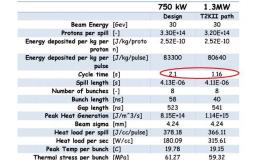




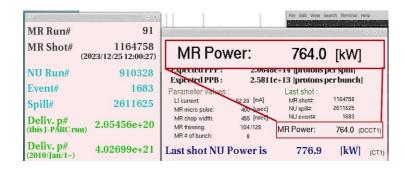
The T2K run schedule: beam upgrade

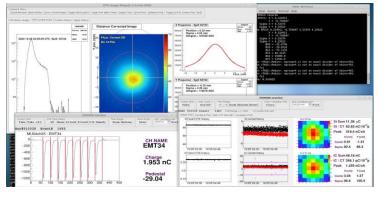
v beam @ J-PARC: dedicated upgrade of the MR facility to reach the 1.3 MW beam power





Beam and Window Parameters

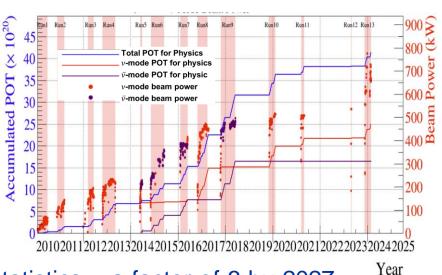




Expect to select 20k ν_{μ} CC0pi interactions in the super-FGD for 0.2e21 POT (1 month)

December 2023 → Beam power increased from 500 to 760 kW stable mode

800 kW reached in 2024 for the first run with the fully upgraded ND280



Steady improvements to reach 1.3 MW by 2027 with an increase T2K statistics ~ a factor of 3 by 2027





153.22

The ND280 experiment: High Angle TPC highlights

- Field Cage (FC)
 - Assembly
 - Production
 - Characterization and Quality Assessment
 - Mechanical
 - Electrical
- Encapsulated Resistive Anode Micromegas (ERAMS)
 - Production of 50 sensors
 - Characterization
 - Detector response, signal and impact on reconstruction
- Impact on HATPC performance





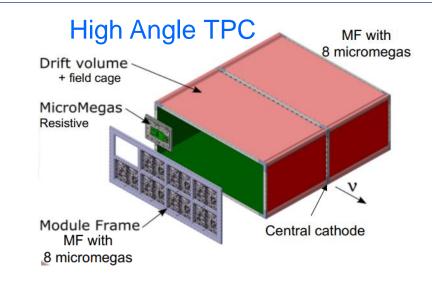
The ND280 experiment: physics requirements

Momentum resolution $\sigma_p/p < 9\%$ at 1GeV/c (neutrino energy)

Energy resolution $\sigma_{dE/dx}$ < 10% (PID muons and electrons)

Space resolution O(500 μm) (3D tracking & pattern recognition)

Low material budget walls ~ 3% X₀ (matching tracks from neutrino active target)



Atmospheric pressure TPC

- Gas: T2K mixture (Ar-CF4-isoC4H10 = 95-3-2)
- Gas contaminants better than O(10 ppm) level
- Drift length 1m
- Central Cathode @ -27kV
- E field unif. < 10⁻³ @1cm from walls
- Low material budget, thin walls
- Active volume ~ O(3m³)

Resistive MicroMegas sensors (ERAMs)

- Overall anode active surface ~ O(3m²)
- Sampling length ~ 80-160 cm
- pads ~ 1x1cm²
- 10k+10k channels / TPC @ End Plates (Anodes)



HATPC: features, challenges, constrains and solutions

Mechanics and Electric Field uniformity

- Min dead space & max active volume in the dipole magnet
- → Rectangular shape & thinnest walls & field shaping electrodes incorporated into the walls
- Electric field uniformity better than 10⁻³ @1cm from walls
 - → Mechanical accuracy: inner surfaces planarity & parallelism ~ O(0.2mm/m)
 - → Shaping Electrode design: Field and Mirror copper strip layers on two sides

of a Kapton foil

- Low material budget walls
 - → lightweight & lowest Z & robust (self supporting)

Electrical insulation Constrains

- HV insulation mantle R > 1TOhm and volume resistivity, HV
 - →geometry: several cm paths for charge from -HV strips to GND shielding (cathode flanges)
 - →insulating materials: very high resistivity & dielectric strength







HATPC: features, challenges, constrains and solutions

Building process: hand lay-up of composite materials on a Mould & polymerization in autoclave at high Pressure

- Autoclave dimensions
 - → Field Cage comprising two halves (symmetrical flanges at central cathode position)
- Hand layup & large dimensions
 - → several hours per process step → very long pot life for epoxy resin
- Mechanical accuracy of geometry → resin curing at low T < O(40°C)

Materials of choice

- lamination materials: Aramid polymers for peels (Twaron) and for honeycomb (Nomex paper)
- epoxy resin limited choice: Resoltech 1054 combined with quality control against contaminants (moisture, ...)
- high insulation layers: Kapton
- box skeleton material: high quality laminated G10







The ND280 experiment: High Angle TPC highlights

- Field Cage (FC)
 - Assembly and layout

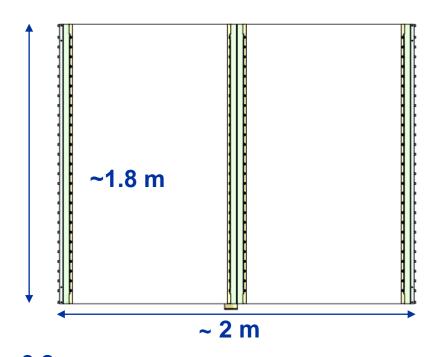


- Production
- Characterization and Quality Assessment
 - Mechanical
 - Electrical
- Encapsulated Resistive Anode Micromegas (ERAMS)
 - Production of 50 sensors
 - Characterization
 - Detector response, signal and impact on reconstruction
- Impact on HATPC performance

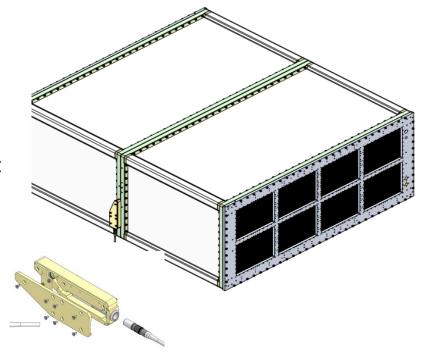


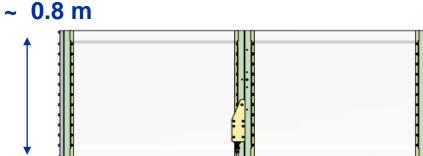


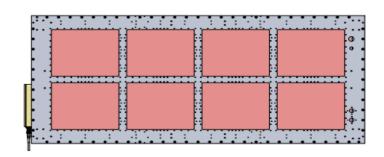
Mechanical HATPC Field Cage assembly



- HATPC in two half FCs
- Central cathode
- Special cathode flanges w/ HV ft
- Two End Plates (Al) supporting
- 8 Readout Modules each



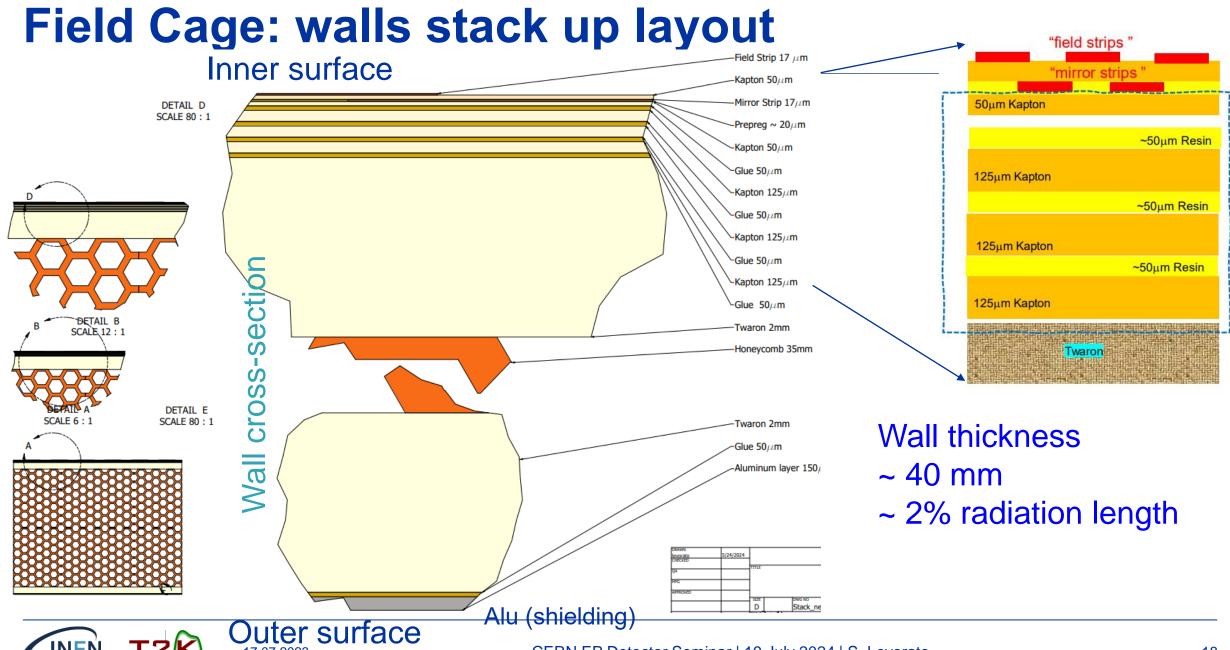


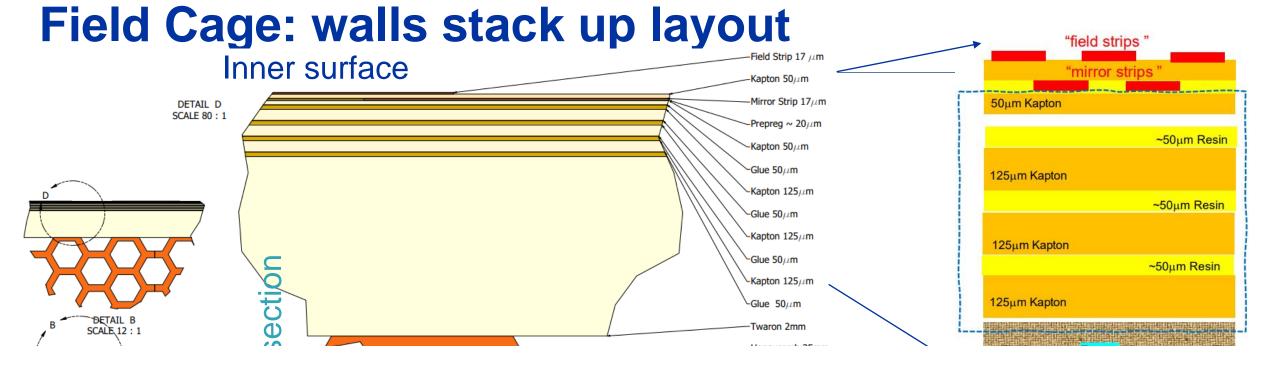




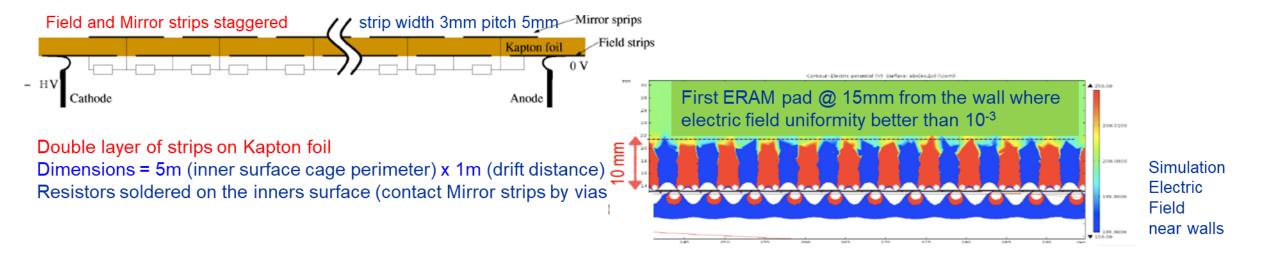








Electric field shaping by two Cu strips layers ('Field' and 'Mirror' strips)



Field cage mechanical details



Field cage mechanical details: charge path to gnd

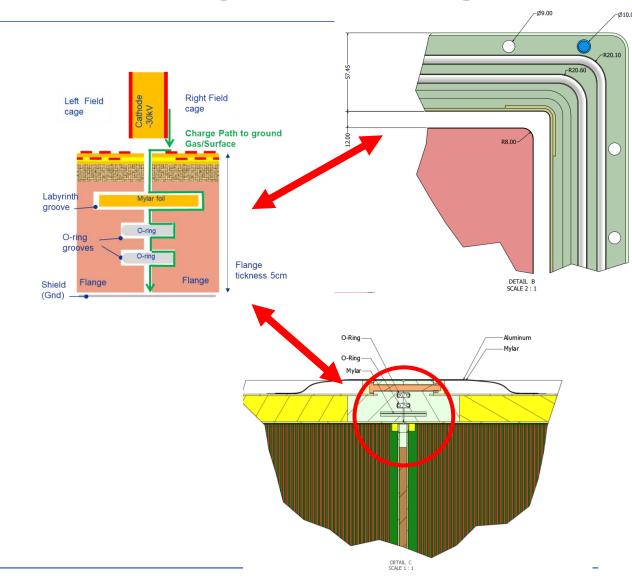
Flange thickness (5cm) too small for degrading -30kV to GND over a flat surface

Three deep grooves

for extending the path from HV to GND for charge moving on surface and with gas flanges

- ~ 7cm thick labirinth
- ~14 cm path lenght
- → voltage drop / path length < 3kV/cm</p>

17.07.2023







The ND280 experiment: High Angle TPC highlights

- Field Cage (FC)
 - Assembly and layout
 - Production



- Mechanical
- Electrical
- Encapsulated Resistive Anode Micromegas (ERAMS)
 - Production of 50 sensors
 - Characterization
 - Detector response, signal and impact on reconstruction
- Impact on HATPC performance





Field Cage building, assembling and characterization

Production at NEXUS company (Barcelona) ~ 10 weeks Validation, QC, electrical and mechanical assembly at CERN ~ 4 weeks

Mould building (INFN)

Mold features

- 1cm thick Alu walls
- Anodyzd. Surfaces
- Waviness compl. iso1302 N8
- Surfaces [⊥] and ∥
 better than 80µm/m
- Mount / unmount geom. reproducibility with high precision







Field Cage building, assembling & characterization at NEXUS

Kapton LayerProduction at NEXUS company (Barcelona) ~ 10 weeks Validation, QC, electrical and mechanical assembly at CERN ~ 4 weeks



5 m perimeter x 1m height (drift length)

- Mold preparation
- Inner Vacuum bag
- Strip Foil positioning
- Thick corners w/ Kapton tape
- Electrical tests on surfaces
- Resin samples electrical Tests





- **Kapton lamination**
- Curing at 40C (fast)
 - Electrical tests on surfaces and resin samples after curing





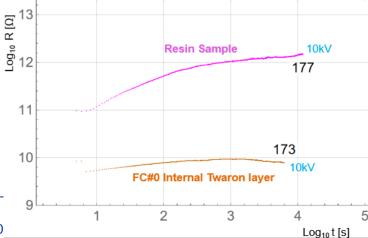
Field Cage building, assembling & characterization at NEXUS **Kapton Layer and inner Twaron**



- First Twaron layer lamination
- Curing at 40C (fast) in autoclave

Electrical tests

- Resin sample
- Inner Twaron layer

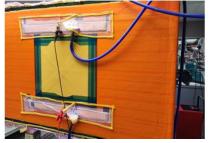


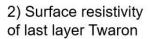
Quality controls – Resistivity of early Layers

- 1) Resistance between mold and 40x45cm2 electrode
- -> volume resistivity of layers



- 3) Resistance between two 6x80cm2 electrodes
- -> mix of surface and volume resistivity









- 1) various methods and electrode types (optimizing contact)
- → consistent measurements









Field Cage building, assembling & characterization at NEXUS Kapton Layer + inner Twaron + G10 Skeleton



- G10 skeleton gluing
- Curing 40C in clean room

Casting low viscosity resin on top flange

→ sealing flange to laminated layers

Autoclave curing at 40C





Field Cage building, assembling & characterization at NEXUS Kapton Layer + inner Twaron + G10 Skeleton + HC + Ext Twaron

- Gluing Nomex Honeycomb
- Curing at 40C in oven

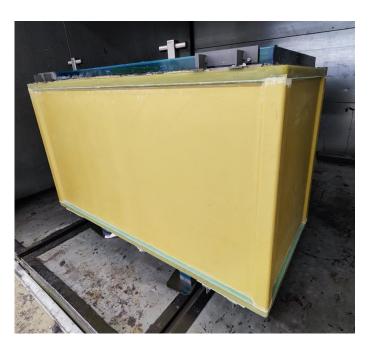




- Resin casting on second flange
- Curing at 40C in autoclave
- Second Twaron peel lamination
- Curing at 40C in autoclave



Outer Twaron peel lamination



Post-curing at 40C in oven (lasting as long as possible)

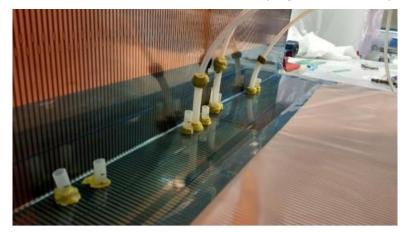


Field Cage machining and final QC at Nexus



Back to NEXUS company for

- Mould removal
- Very fine polishing of flanges
- Correction of defects (eg bubbles)













The ND280 experiment: High Angle TPC highlights

- Field Cage (FC)
 - Assembly and layout
 - Production
 - Characterization and Quality Assessment



- Mechanical
- Electrical
- Encapsulated Resistive Anode Micromegas (ERAMS)
 - Production of 50 sensors
 - Characterization
 - Detector response, signal and impact on reconstruction
- Impact on HATPC performance





Inner cage surfaces polishing





Checking grooves for o-ring and for charge labyrinth on cathode flanges

Looking for defects on strips and strip-strip short-circuits and repairing them

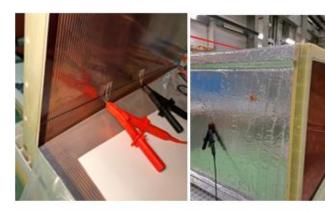


Soldering voltage divider resistors

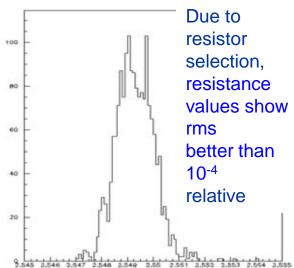


Two voltage dividers In parallel $\sim\!400~5.1M\Omega$ resistors each: Overall R $\sim\!1G\Omega$

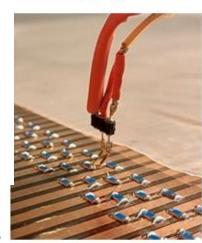




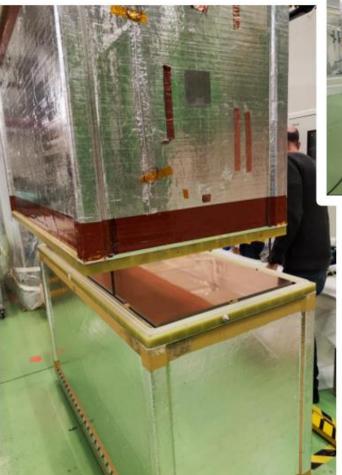
Measuring strip-strip and strip-shield insulation at high voltage



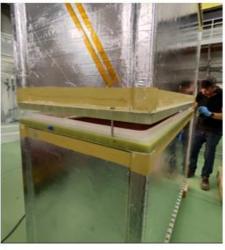
Measuring single resistors



Vertical assembly of two Field Cages into HATPC



Cathode assembly





Cathode assembly



Connection of last strips to cathode and to high voltage feedtrough



High Voltage feedtrough external connection



High voltage tests after assembly





- 1) He leak tested sniffer (air + 30mbar of He)
- 2) Tested against gas density changes
- He Over-pressure (+20mbar)
- Air Under-pressure (-20mbar)

17.07.2023

Several T,P,RH sensors Inside FC

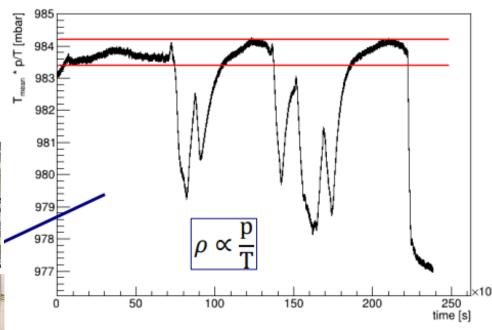
BME280 – T_{cage}, P, RH IR sensor - T_{gas} Thermocouple and Pt100 Voltage divider current meas

Gas density corrected for Volume variation (due to Pin - Pout)

$$= \frac{Pin(t)}{Tin(t)/Tin(0)} \left(1 - \frac{\Delta V}{V0}\right) (Pin - Pout)$$



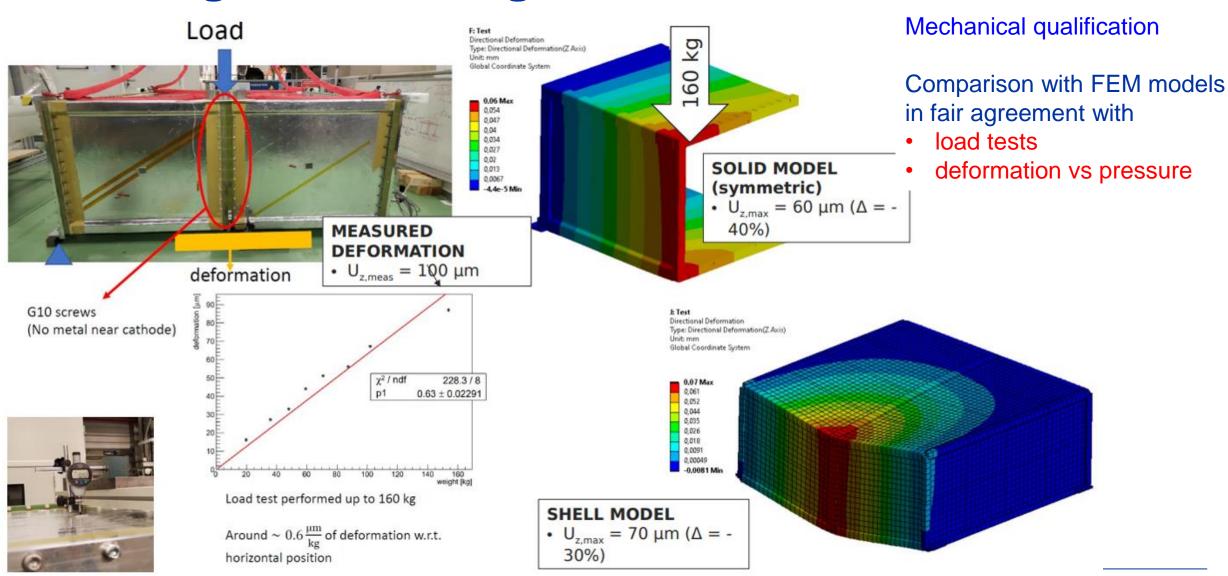
Gas leakages qualification



=> Overall Leak < 10⁻³ mbar L/s





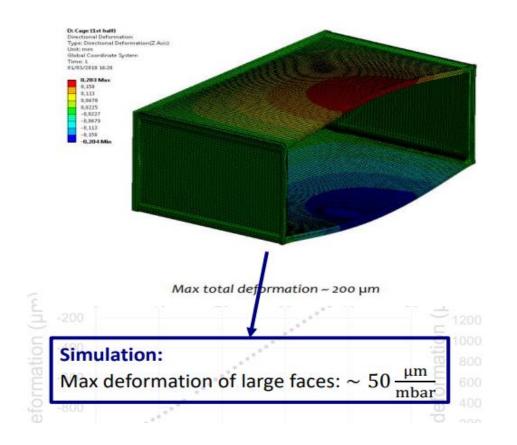






17.07.2023

Mechanical qualification



Comparison with FEM models in fair agreement with

- load tests
- · deformation vs pressure

Max total deformation ~ 60 µm

Data:

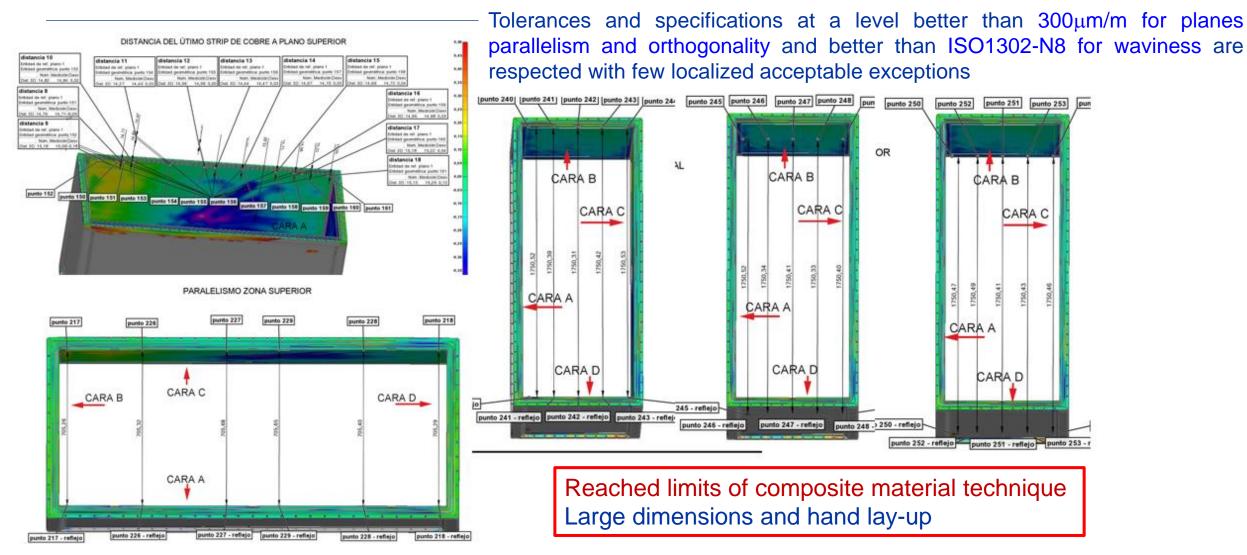
Max deformation of large faces: $\sim 50 \frac{\mu m}{mbar}$

Max deformation of small faces: $\sim 8 \frac{\mu m}{mbar}$

Almost linear in the studied pressure range



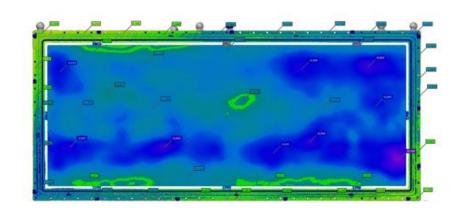
Field Cage assembling, metrology at Nexus

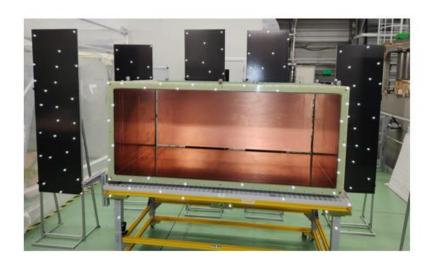






Field Cage assembling, metrology at CERN



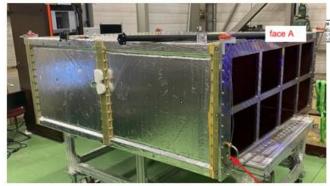


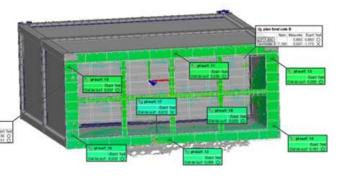
Metrology at CERN Bottom—HATPC (2023) (Two separate cages and cathode)

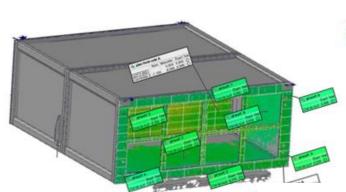


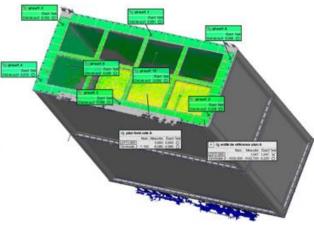


Metrology at CERN Top-HATPC (2024, single whole TPC 3D metrology)





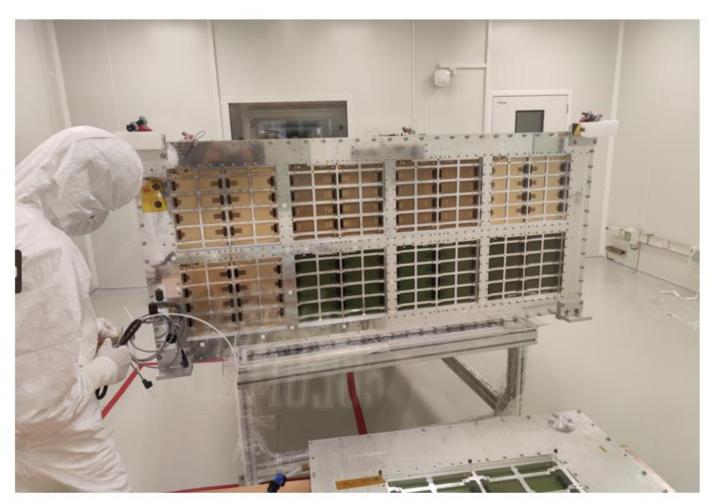




Measured internal geometry after assembly agrees with nominal CAD with pull better than CERN EP Detector Semi 300μm with few localized, acceptable exceptions

Field Cage assembling, ERAM installation

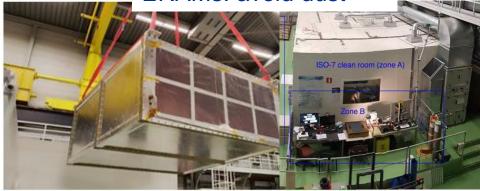
Assembly the 16 ERAMs in Clean room for each TPC



Grey tent area in front of Clean Room large entrance for enhanced clean conditions







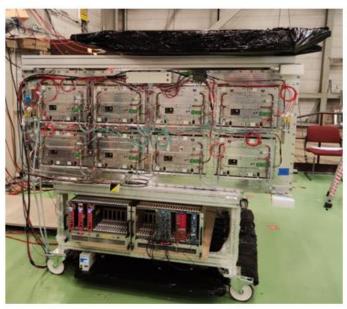


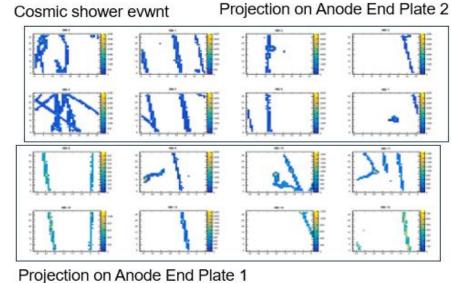


Field Cage assembling, commissioning with cosmics

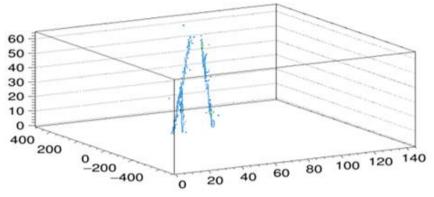








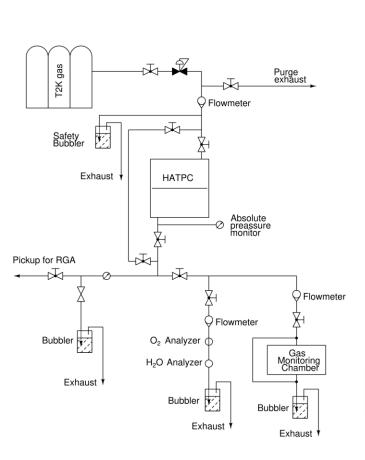


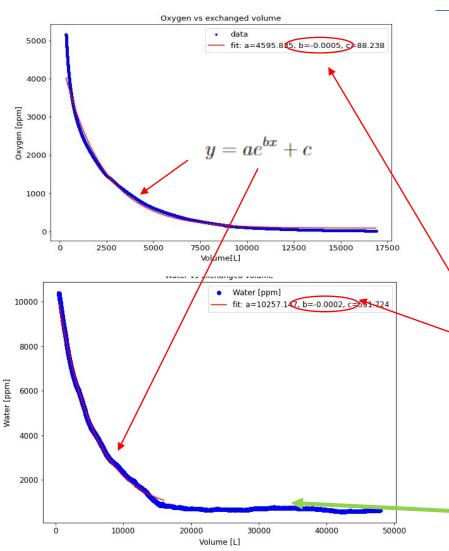


Cosmic tracks interaction evwnt



Field Cage assembling, commissioning: gas contamination at CERN





Water and Oxygen contamination evolution

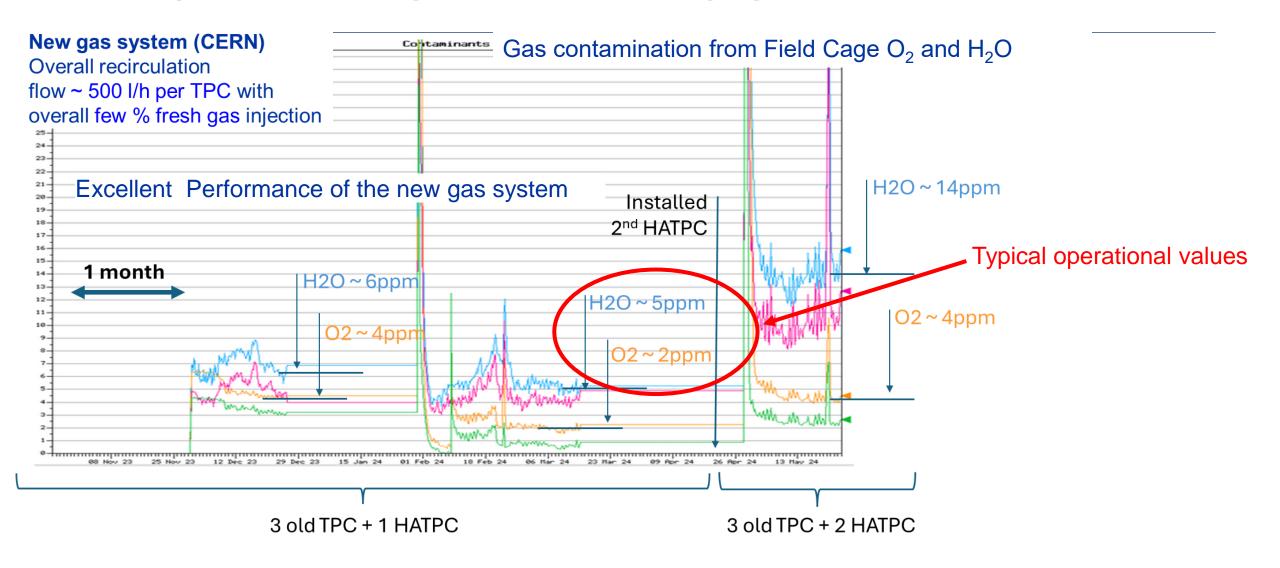
Large amount of water uptake by Kapton: 2% in mass, with respect to dry Kapton, ~ about 70 g → purging time ~ a couple of months

Different dragging coefficient? **Under investigation**

$$\frac{dc(t)}{dt} + \frac{f}{V}c(t) = \delta$$

δ water desorption from walls \rightarrow 0.06 g/day water removal / desorption (long)

Field Cage assembling, commissioning: gas contamination at J-PARC

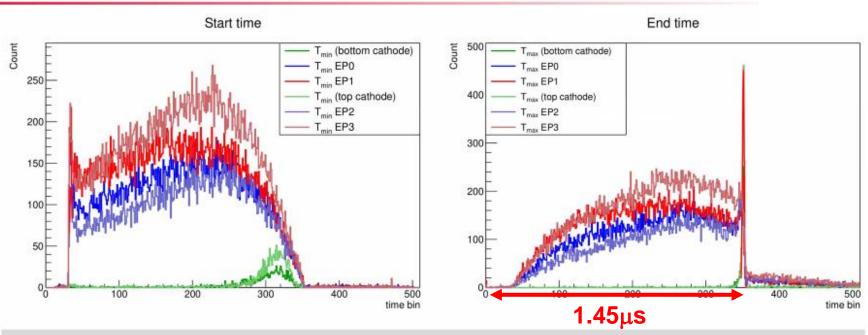






Field Cage assembling, commissioning: drift velocity measurement

Drift velocity

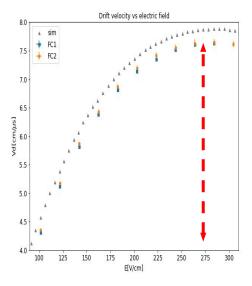


Gas contamination $H_2O \sim 10 \text{ ppm } H_2O @ J\text{-PARC All TPCs}$

Drift velocity in bottom HATPC: 7.769 ± 0.005 cm/µs

Drift velocity in top HATPC: $7.772 \pm 0.005 \text{ cm/}\mu\text{s}$

Perfect agreement with expectations (Magboltz)



Gas contamination from Field Cage - O $_2$ and H $_2$ O included 500 ppm H $_2$ O @ CERN Bottom TPC



The ND280 experiment: High Angle TPC highlights

- Field Cage (FC)
 - Assembly and layout
 - Production
 - Characterization and Quality Assessment
 - Mechanical
 - Electrical

An outsider: Field Cage 0? Electrical Issues, what we understood... and learnt

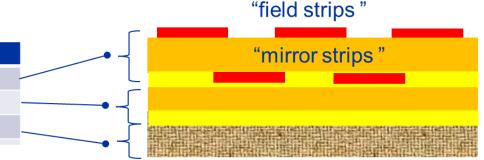




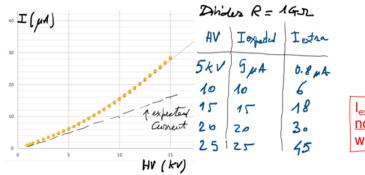
Insulation issue in full scale FC0 prototype

Innermost layers stack (first full-scale FC prototype)

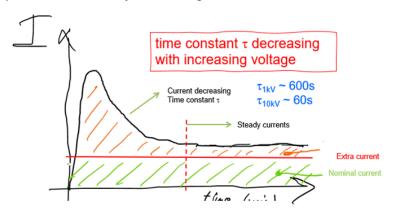
Thickness	
Cu 17μm / Kapton 50μm / Cu 17μm	-
Glue 20μm / Kapton 25μm	
2mm	
	Cu 17μm / Kapton 50μm / Cu 17μm Glue 20μm / Kapton 25μm



Current drawn by voltage divider starting in large excess wrt nominal at power on and slowly decreasing to lower value but still in excess



l_{extra} increasing non linearly with voltage Current drawn by voltage divider starting in large excess wrt nominal at power on and slowly decreasing to lower value but still in excess



Observed extra-currents in excess w. r. t. expected from voltage divider

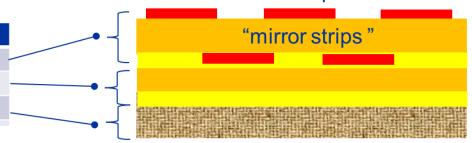




Insulation issue in full scale FC0 prototype

Innermost layers stack (first full-scale FC prototype)

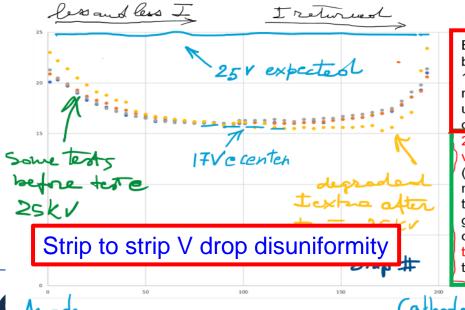
Material	Thickness
Cu Strips on Kapton foil (electrodes)	Cu 17μm / Kapton 50μm / Cu 17μm
"Coverlay" (strip insulation / protection)	Glue 20μm / Kapton 25μm
Aramid Fiber Fabric (Twaron™)	2mm



"field strips"

Strip-Strip Potential difference of the strips @ 5kV

Voltage difference between Field strips (every 5 strips) ie V_1-V_2 , V_5-V_6 , $V_{10}-V_{11}$, ... V_1 = anode, V_{196} = cathode



Behaviour explained bv either 1) Voltage divider resistors values not uniform along the divider

2) current diverted from voltage divider (drawn from strips) more and more along the 1st half of the cage going from anode to cathode returned to the divider (pulled by the strips) in the 2nd half

Measurement of Surface resistance of strip foil

(resistors removed)

154JL

Resistance between single strips is very high $O(T\Omega)$...but when joining some tens of strips to form a single large electrode then finite resistances are measured

Example: measured R ~15 GΩ @ 1kV between two electrodes formed by 20Field+20Mirror strips each (surface of single electrode is huge ~ 0.5m²) ! No voltage divider there, ie all strips disconnected

Resistance is

- Independent of the distance between electrodes
- Linearly dependent of the number of the strips
- → not a surface resistance!

Measured R is rising with time (slow) up to saturation

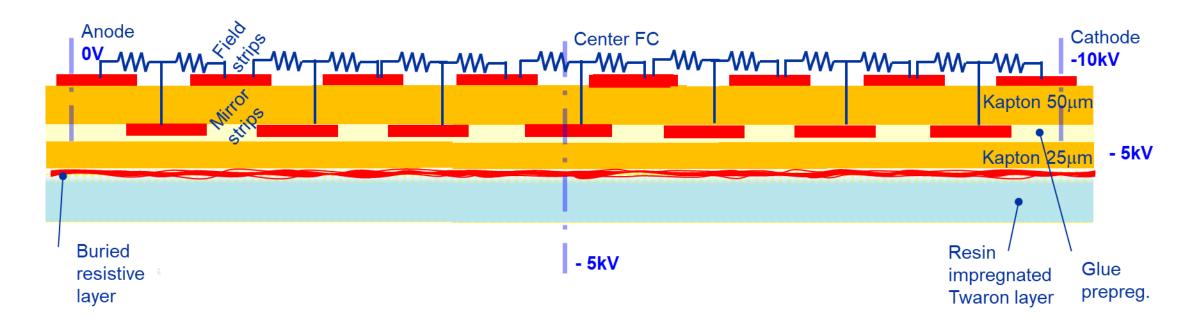
- when repeating measurement, go faster to saturation
- when inverting polarity of electrodes, slow again
- → looks like due to dielectric polarization / relaxation
- → or capacitor charging trough high resistance

Find similar value of Resistance for same dimension electrodes formed in the Field Cage and on a strips foil when aluminum foil is placed underneath the foil \rightarrow next 44

Buried resistive layer: a possible explanation

All observed features could be explained by the combination of two factors:

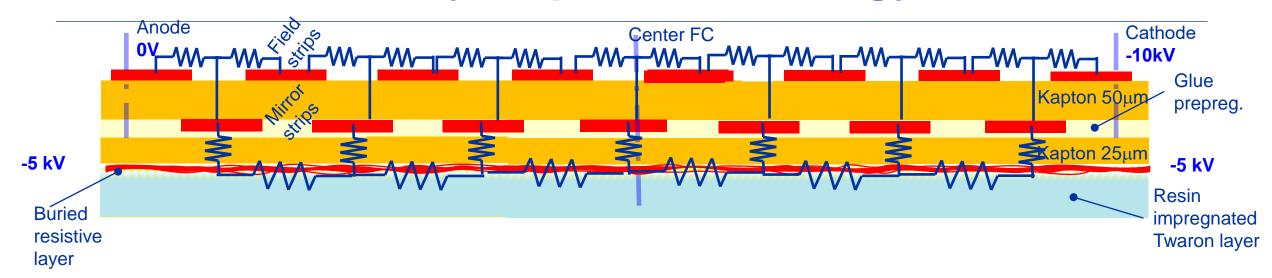
- Presence of a resistive layer buried underneath the Kapton coverlay layer protecting the mirror Mirror strip
- 2) Low resistivity of the coverlay Kapton layer







Buried resistive layer: phenomenology



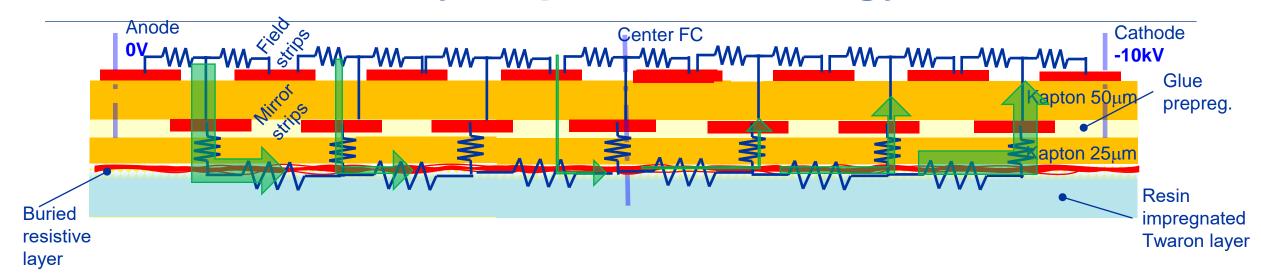
After applying HV after applying HV (eg -10kV) to the cathode, two phases:

- 1) Transient state: in time scale depending on the contaminated layers resistivity (in our case very short O(10s) time scale) the buried resistive layer become ~ equipotential (setting at intermediate potential -5kV) by drawing charge from the strips
- 2) Steady state: Mirror strips on the Anode, first half convey current to the buried layer, while mirror strips on the Cathode side draw currents from the buried layer





Buried resistive layer: phenomenology



After applying HV after applying HV (eg -10kV) to the cathode, two phases:

- 1) Transient state: in time scale depending on the contaminated layers resistivity (in our case very short O(10s) time scale) the buried resistive layer become ~ equipotential (setting at intermediate potential -5kV) by drawing charge from the strips
- 2) Steady state: Mirror strips on the Anode, first half convey current to the buried layer, while mirror strips on the Cathode side draw currents from the buried layer





Buried resistive layer: verification

In fact we verified the following

- 1) Coverlay Kapton volume resistivity $\sim 1G\Omega$ cm much lower than datasheet)
- 2) Twaron layer facing the coverlay featured surface resistivity ~ 1G/



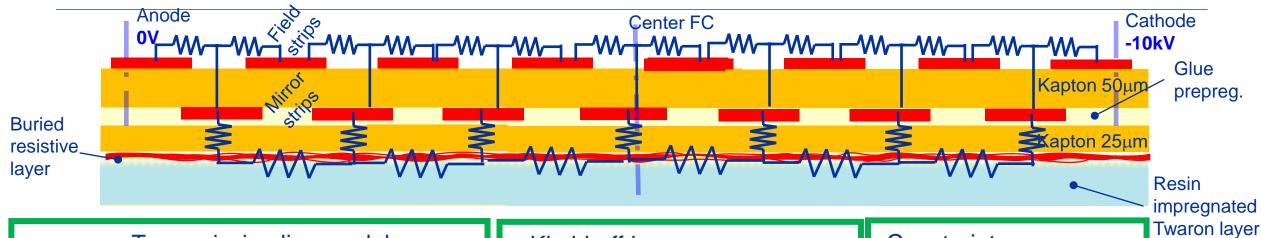
Both features could on turn be explained by the **accidental use of antistatic spray (resistive)** on the back of the strip foil (ie on the coverlay) after the strip foil was fixed on the Mould, in order to keep the huge foil surface (5m²) clean from dust and other possible contaminants. The spray contaminated both the Kapton coverlay (being very easily adsorbed) and the innermost layer of the Twaron (being mixed with the resin which impregnates the fiber fabric, during the Twaron lamination phase)

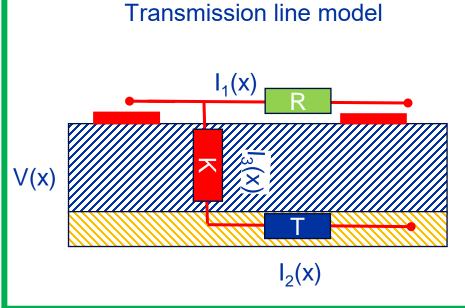
We could not exclude alternative sources of contamination affecting the resin and making it resistive (eg presence of water if epoxy not treated in vacuum after mixing)

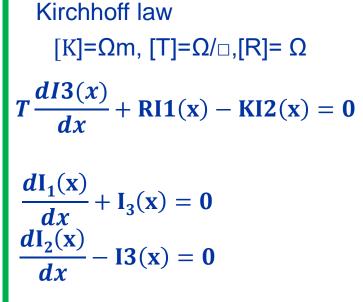


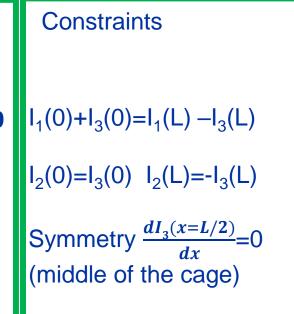


Buried resistive layer: electrical model

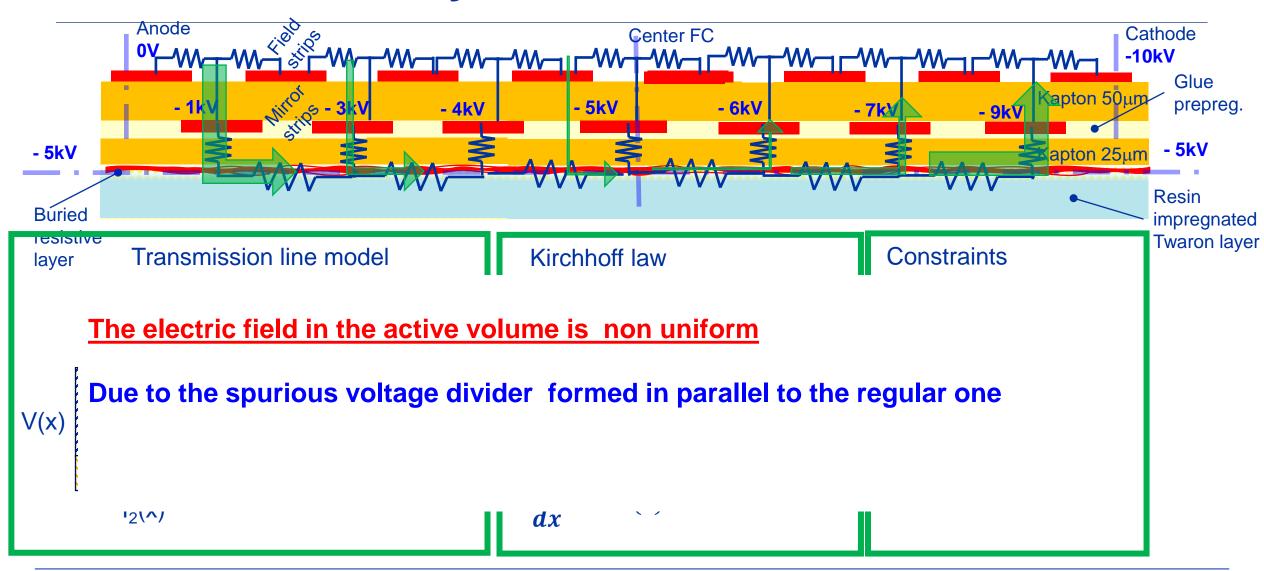








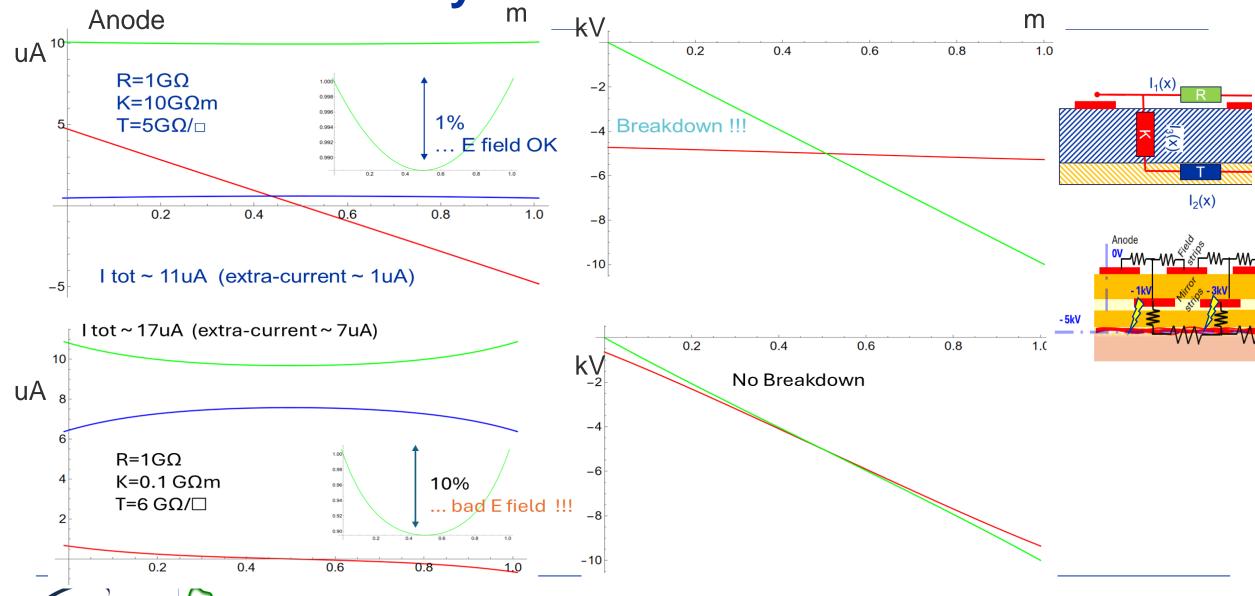
Buried resistive layer: electrical model results



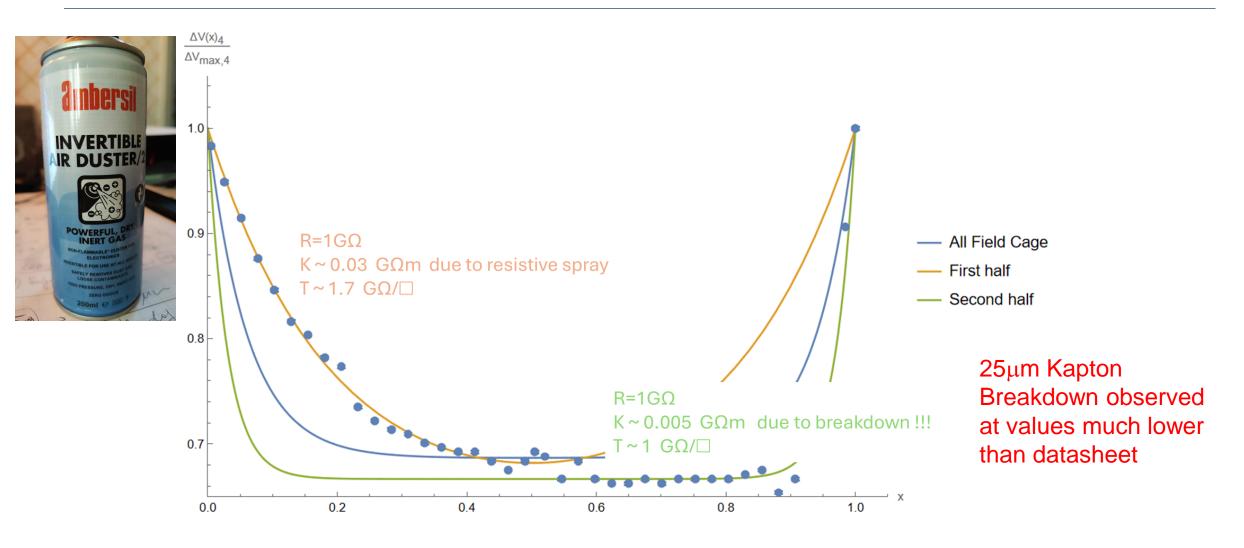




Buried resistive layer: electrical model results



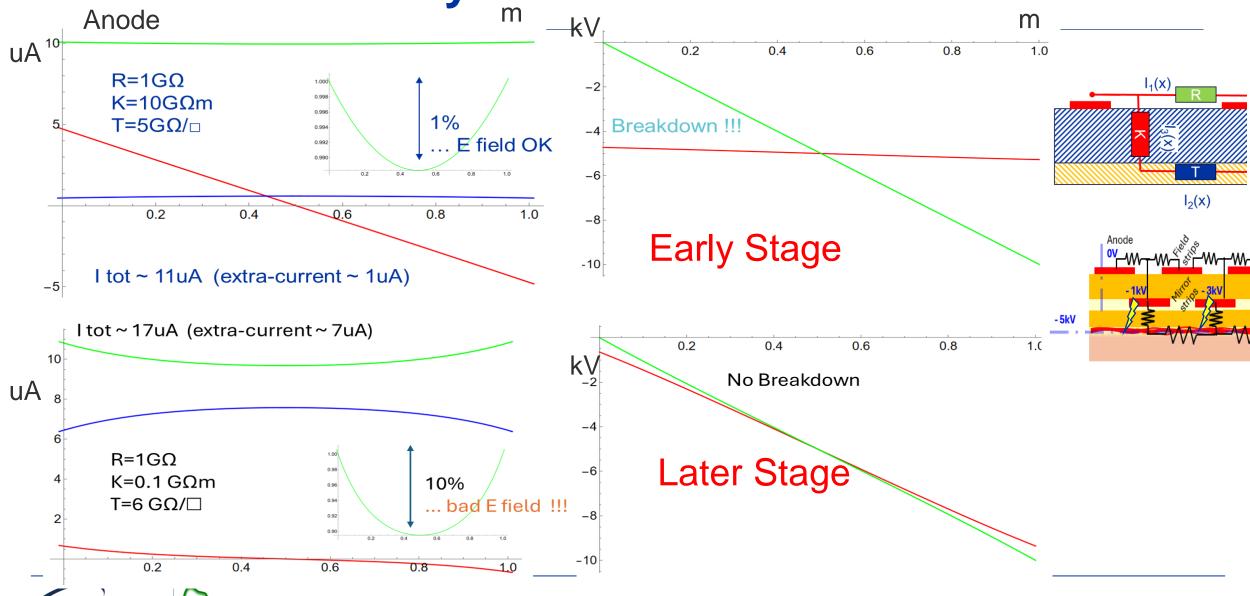
Buried resistive layer: fit to the data







Buried resistive layer: electrical model results



Final layout, materials and procedures fixed for the series production

Key points to avoid failures

- no resin contamination !!! Note: usually glues and resins are the weakest points
- Interpose between strips and Twaron layers a "thick" layer of insulator featuring
 - High resistivity $\rho_{\rm v} > 10^{15} \ \Omega {\rm cm}$
 - Dielectric strength > 150kV/mm

Final layout of the stack: minimal changes to design

17.07.2023

- new strip foil w/ thicker Kapton coverlay 50μm + 25μm glue (produced at CERN, gluing in vacuum with press)
- 3 layers of Kapton: 125μm + 50μm resin each (to be laminated on the back of strip foil on the mold) thickness Kapton+Resin ~0.5mm → "vertical R" below 1 strip O(10TΩ) @ 10kV

Materials: Same insulating materials (Kapton + Aramid) and same resin (Resoltech)

Production procedure and enhanced countermeasures and QC

- Minimize moisture trapped in wall layers: drying in oven Kapton & Twaron just before use
- QC epoxy contamination -> proper control of mixing and de-gassing process (new mixing / degassing tools and QC) and ... avoid antistatic spray...
- QC electrical resistivity measurements after each early step in the production





~50µm Resin

~50um Resin

~50µm Resin

125µm Kapton

125µm Kapton

125um Kapton

The ND280 experiment: High Angle TPC highlights

- Field Cage (FC)
 - Assembly and layout
 - Production
 - Characterization and Quality Assessment
 - Mechanical
 - Electrical
- Encapsulated Resistive Anode Micromegas (ERAMs)



- Production of 50 sensors
- Characterization
- Detector response, signal and impact on reconstruction
- Impact on HATPC performance

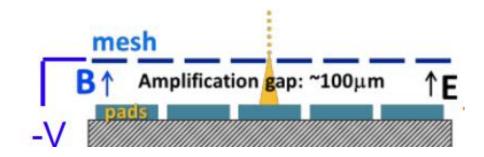




ERAM: MicroMegas with DLC resistive foil

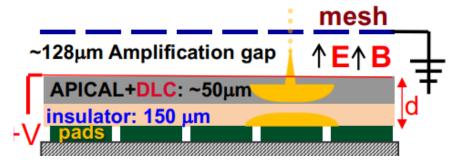
Resistive layer enables Charge spreading

- → space resolution below 500µm with larger pads
- → less FEE channels (lower cost)
- → improved resolution at small drift distance (where transverse diffusion cannot help)



Resistive layer prevents charge build-up and hides sparks

- → enables operation at higher gain
- → no need for spark protection circuits for ASICs
 - → compact FEE → max active volume



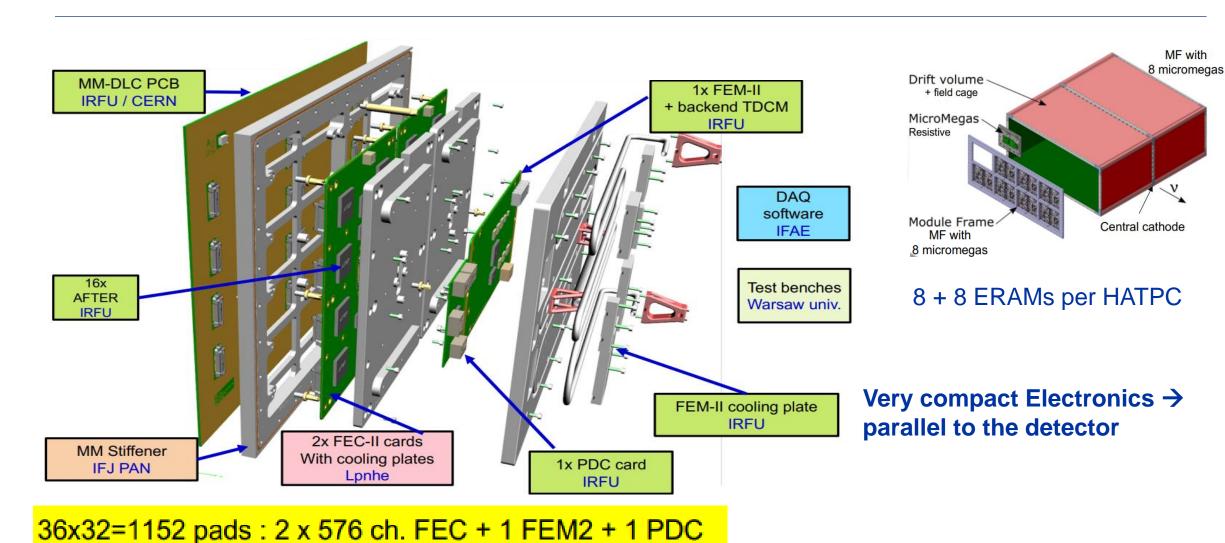
Resistive layer encapsulated and properly insulated from GND

- → Mesh at ground and Resistive layer at +HV
- → improved field homogeneity → reduced track distortions
- → better shielding from mesh and DLC → potentially better S/N





ERAM Module breakout







Charge spread on low resistivity foil

Charge Spreading 2D telegraph eqn. solution time scale is driven by RC

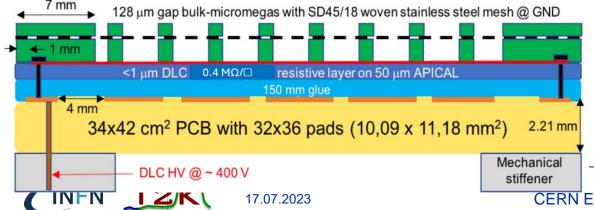
R- surface resistivity

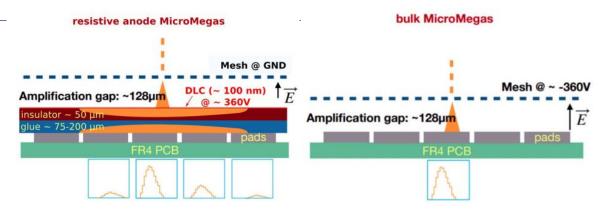
C- capacitance/unit area

Gaussian spread

$$\frac{\partial \rho}{\partial t} = h \left[\frac{\partial^2 \rho}{\partial r^2} + \frac{1}{r} \frac{\partial \rho}{\partial r} \right] \longrightarrow \rho(r, t) = \frac{RC}{2t} e^{-r^2 RC/(4t)}$$

$$\sigma_r = \sqrt{\frac{2t}{RC}} \begin{cases} t \approx shaping time (few 100 ns) \\ RC_{[ns/mm^2]} = \frac{180 R_{[M\Omega/\blacksquare]}}{d_{[\mu m]}/175} \end{cases}$$





Final ERAM layout choice for series production:

Considering pads of 11x10 mm² parameters

- 400 kΩ/□ DLC resistivity low resistivity
- 150 μ m thickness glue $C_{dlc-pad/gnd}$ ~ O(20pF)

 \rightarrow RC ~ O(100ns/mm²)

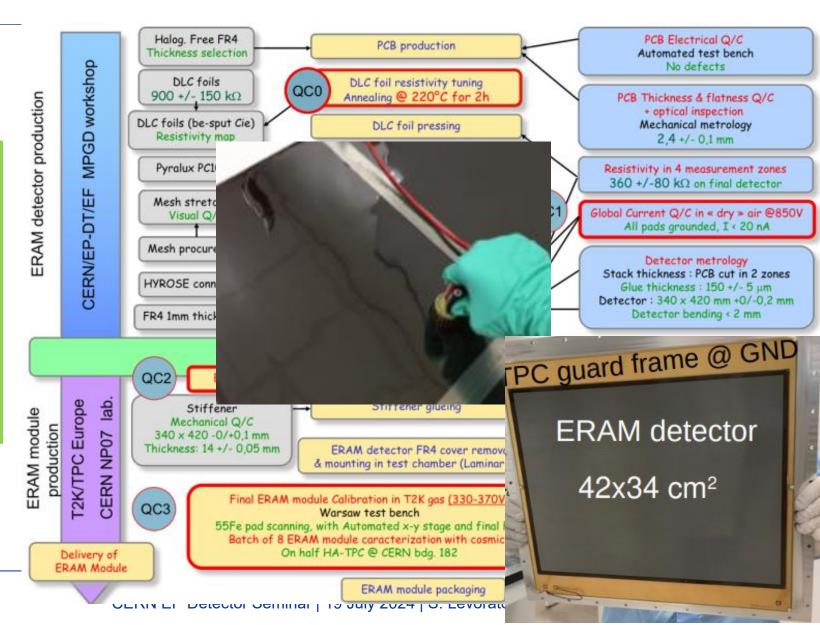
Trade-off optimal charge spread VS spark protection

Gain not affected by resistivity (transparency to induced signals is guaranteed)

ERAM production ~ 50 detectors

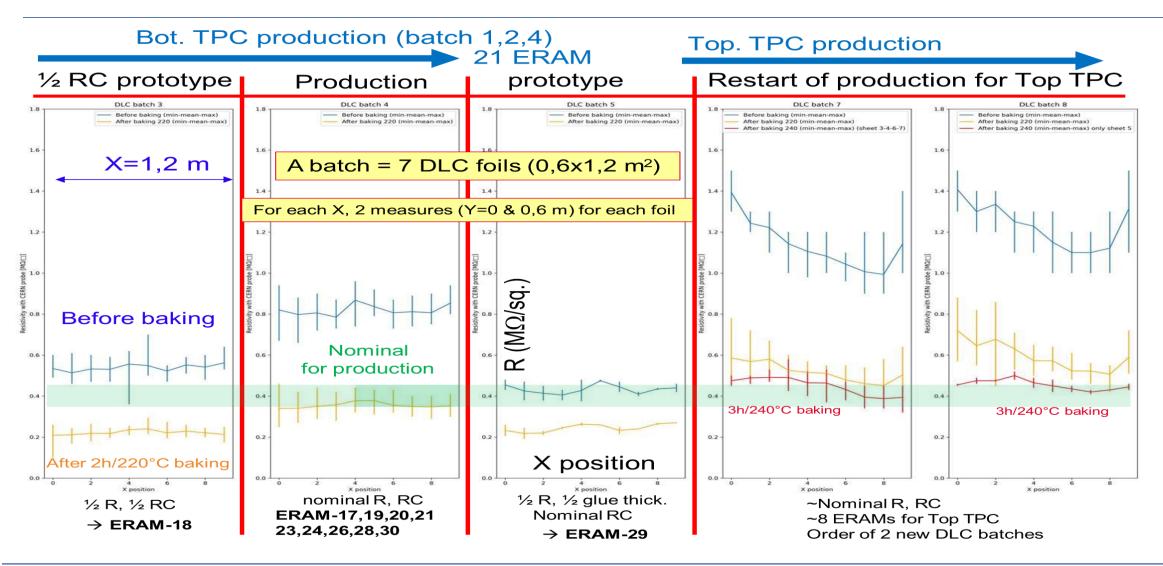
Crucial steps in production (CERN MPGD workshop)

- 1) Selecting DLC foil resistivity
- Large variations from DLC provider
- Value stable after annealing
- Gluing steps by Pressing
- DLC to PCB
- Stiffener to DLC-PCB





DLC layer: foil selection, QC





The ND280 experiment: High Angle TPC highlights

- Field Cage (FC)
 - Assembly and layout
 - Production
 - Characterization and Quality Assessment
 - Mechanical
 - Electrical
- Encapsulated Resistive Anode Micromegas (ERAMS)
 - Production of 50 sensors
 - Characterization
 - Detector response, signal and impact on reconstruction
- Impact on HATPC performance





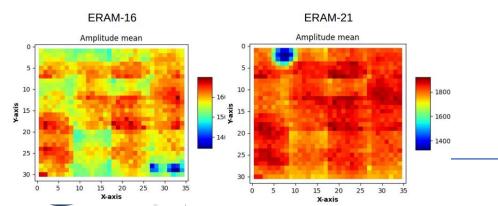
ERAM Series production experience: X-ray scan

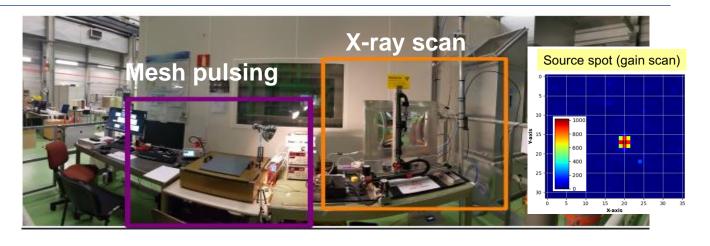
X-rays Test Bench at CERN fundamental to

- 1) Qualify, characterize and calibrate all prototypes and series ERAMs
- 2) Support the development of detailed ERAM response model

A) Mesh Pulsing: before and after stiffener gluing

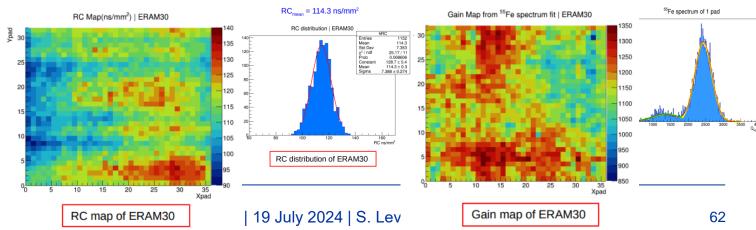
Aim: detector geom defects (eg pillar detach), stiffener gluing issues, electronic noise



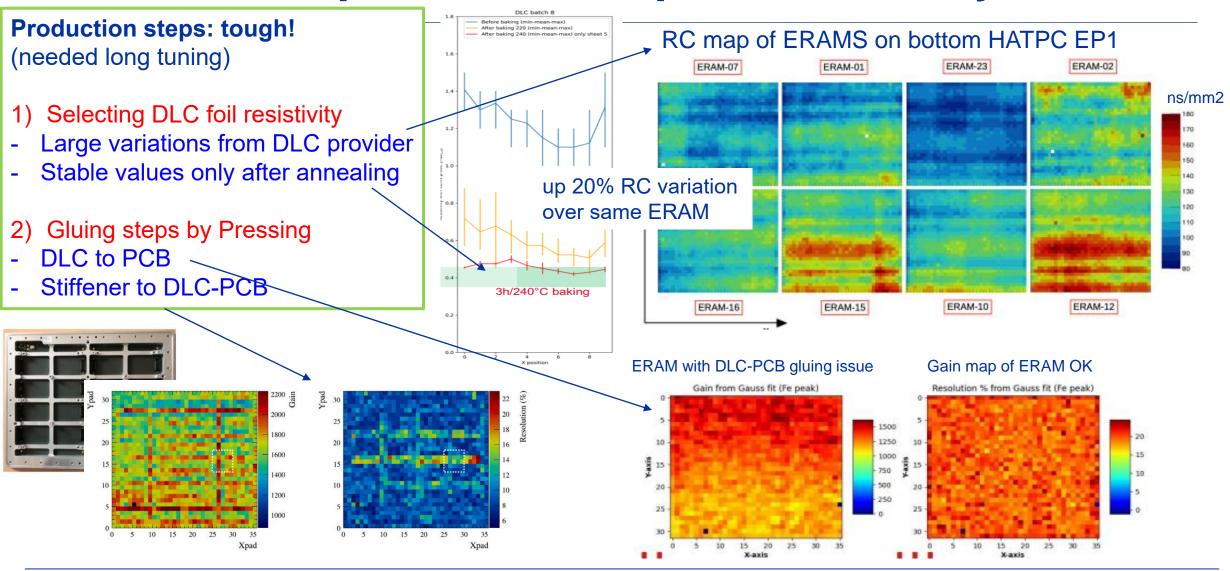


B) X-ray scan of finalized detectors with final electronic modules. Remote controlled station for scanning with mm step fine steps

Aim: QC and fine calibration in terms of gain, resolution and RC



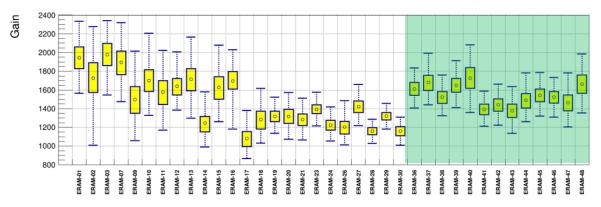
ERAM Series production experience: X-ray scan

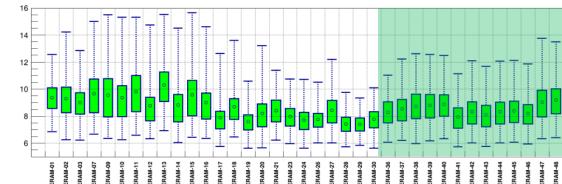




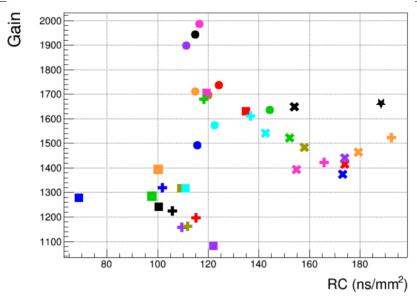
ERAM Series production experience

Gain distribution @350V

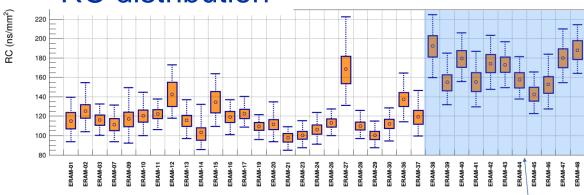


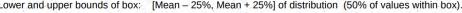


Energy resolution



RC distribution







Resolution (%)



ERAM Assembly and Operation experience

Low resistivity DLC O(500kΩ/□) [after annealing] features

- Optimal charge spread → uniform response across pad (combined with C ~ O(20pF/cm²)
- Fast Q removal and Effective Protection agains sparks included at moderate rates ~ O(1kHz) tracks crossing pads
- Leakage currents at level of few nA in normal conditions (no beam)

Challenging installation conditions

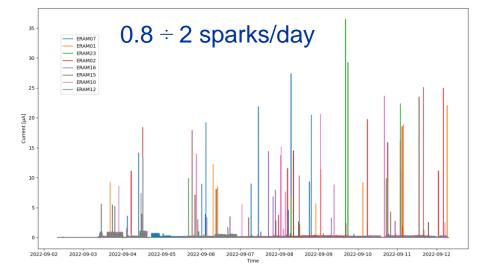
- → high sensitivity to dust
- → low H2O level (100ppm) before HV on

ERAM @ test beam 2022

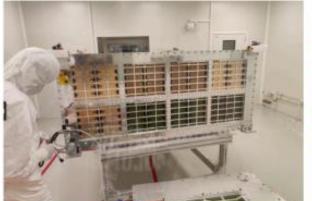
17.07.2023

ERAM stability

- We have operated 8 ERAM modules during ~ 7.7 days @ CERN 2022
 - Intense beam activity
 - One ERAM module was not working during cosmic test (solved by hammering on it)
- We have observed no major issue
- The spark rate is between 0.8 and 1.7 per day (higher than 2uA)

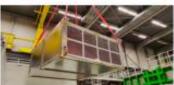


ERAM assembly (and storage) in Clean Room



Grey tent area in front of Clean Room large entrance for enhanced clean conditions









The ND280 experiment: High Angle TPC highlights

- Field Cage (FC)
 - Assembly and layout
 - Production
 - Characterization and Quality Assessment
 - Mechanical
 - Electrical
- Encapsulated Resistive Anode Micromegas (ERAMS)
 - Production of 50 sensors
 - Characterization
 - Detector response, signal and impact on reconstruction



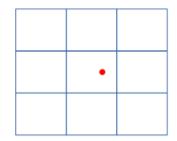




The ND280 experiment: High Angle TPC highlights

How does the signal look? point deposition for example

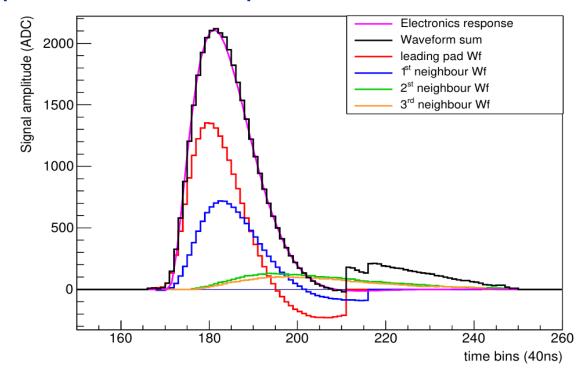
Charge deposited punctually on a pad (X ray)



ADC signal: max 4096 counts Time window of 511 time bins

Time bin (typ.): 40 ns (25 MHz sampling)

Peaking time (typ.): 412 ns



Leading pad: highest and earliest signal

⇒ current induced on pads from by avalanche, ie **ions** signal (as electrons' signal is too fast)

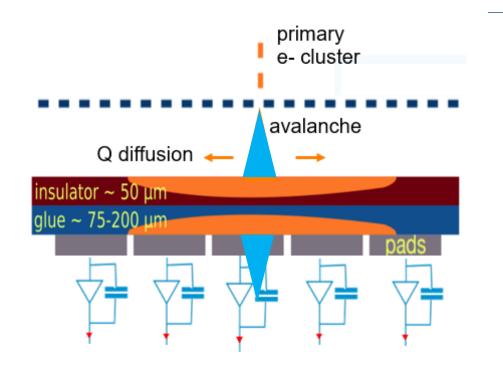
Adjacent pads: lower and later signals

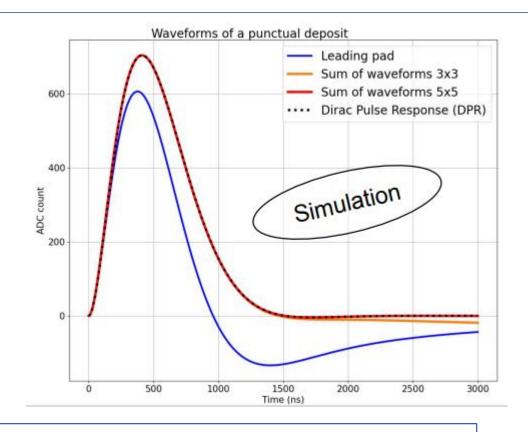
⇒ current induced by potential field adjustments after <u>electrons</u> are collected by on DLC (current induction by "charge spread on resistive layer")

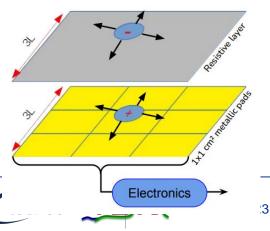




Reconstruction of charge deposition 1/2



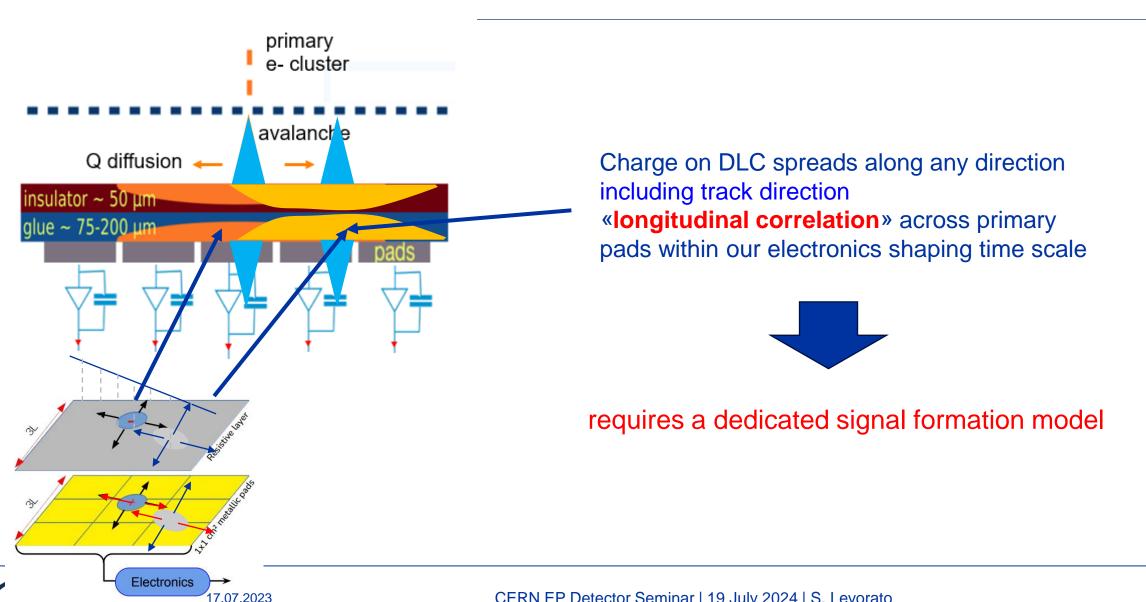




Recovering information about deposited Q is not trivial

Within our electronics shaping time scale in primary pads, the <u>signal of ions</u> is <u>«diluted»</u> by the <u>signal of charge spreading</u> => Need combining information of all pads (primary and secondary)

Reconstruction of charge deposition 2/2



ERAM response – Signal formation model

e- cluster

avalanche

Vc = -350, Va = 460

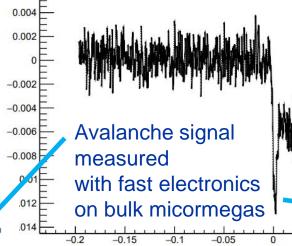


In the time scale of our shaping time O(100ns) Charge spread is properly described by

Solutions of 2D diffusion eqn.

$$\Rightarrow \frac{\partial^2 \rho}{\partial^2 t} = \frac{1}{RC} \left(\frac{\partial^2 \rho}{\partial^2 x} + \frac{\partial^2 \rho}{\partial^2 y} \right) \text{ with } RC = \frac{C_S}{\sigma} \text{ in } s/m^2$$

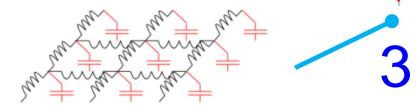
O diffusion



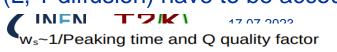
lons signal (slow)

Electron signal (too fast for our shaping times)

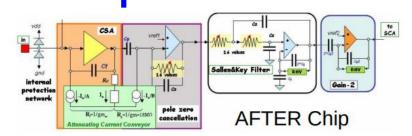
Electrical model of the sensor



Note: of course **gas transport properties** (L, T diffusion) have to be accounted for



FEE Response Function



CERN EP De
$$f(t; w_s, Q) = e^{-w_s t} + e^{\frac{-w_s t}{2Q}} \left[\sqrt{\frac{2Q - 1}{2Q + 1}} \sin\left(\frac{w_s t}{2} \sqrt{4 - \frac{1}{Q^2}}\right) - \cos\left(\frac{w_s t}{2} \sqrt{4 - \frac{1}{Q^2}}\right) \right]$$

ERAM detector response: reconstruction

Use of the model for Reconstructing the charge deposition

Due to square shape of ERAM pads, the classical method (PRF+clustering) works OK only for tracks with horizontal or vertical direction (wrt pads coordinates)

Better methods use solutions of 1D or 2D telegraph equation in order to

- 1) compute the pattern templates for charge diffusion on DLC
- 2) calculate the overall expected signal waveform per each pad
- 3) find the best matching with the recorded waveforms

Its computationally heavy → different approximations are used for different analysis some examples and illustration algorithms and TPC performances

- 1) X-rays analysis ERAM characterization
- 2) Measurement of dE/dx Particle Identification
- 3) Track reconstruction momentum measurement





Reconstructing X-rays charge deposition

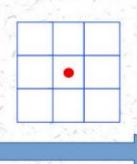
 $Q_{pad}(t)$ = Solution of 2D Teq. for diffusion of initial Q deposited charge (point-like, delta-pulse initial conditions)

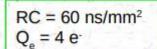
$$Q_{pad}(t) = \frac{Q_e}{4} \times \left[erf(\frac{x_{\mathsf{high}} - x_0}{\sqrt{2}\sigma(t)}) - erf(\frac{x_{\mathsf{low}} - x_0}{\sqrt{2}\sigma(t)}) \right] \times \left[erf(\frac{y_{\mathsf{high}} - y_0}{\sqrt{2}\sigma(t)}) - erf(\frac{y_{\mathsf{low}} - y_0}{\sqrt{2}\sigma(t)}) \right]$$

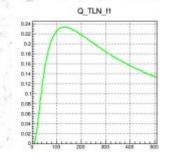
$$\sigma(t) = \sqrt{\frac{2t}{RC}}$$

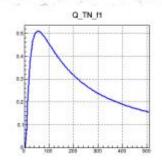
- Obtained from Telegrapher's equation for charge diffusion.
- Integrating charge density function over area of 1 readout pad.
- Parameterized by 5 variables:
 - x₀
 y₀
 Initial charge position
 - t_o: Time of charge deposition in leading pad
 - · RC : Describes charge spreading
 - Q_e: Total charge deposited in an event

 x_H , x_L : Upper and lower bound of a pad in x-direction y_H , y_L : Upper and lower bound of a pad in y-direction

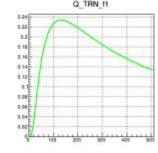


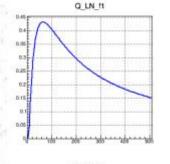


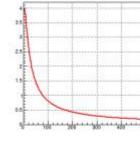


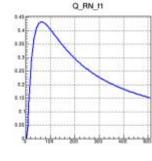


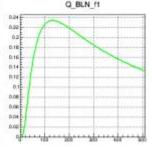
Q Lead ff

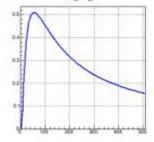


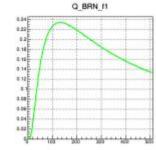














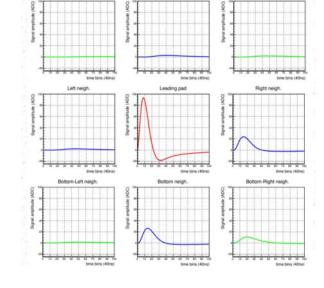
Reconstructing X-rays charge deposition

WF templates

Current induced on a pad dQpad(t) / dt to be convoluted with electronics transfer function R(t)



electronics transfer function R(t) $dQ/dt \otimes R(t) = Q(t) \otimes dR(t)/dt$ Q(t) $\otimes dR(t)/dt$ is more practical



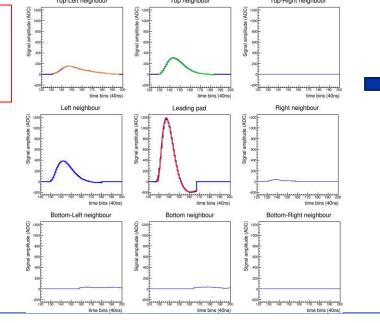
Simultaneous fit of waveforms of Leading pad + Neighboring pads to get the best 5 parameters

- X₀
 V₂

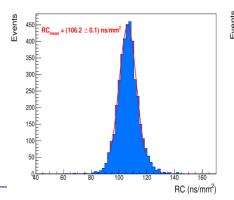
 Initial charge position
- · t_o: Time of charge deposition in leading pad
- · RC : Describes charge spreading
- · Q : Total charge deposited in an event

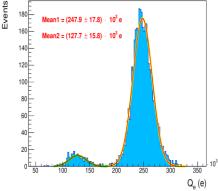
 x_H , x_L : Upper and lower bound of a pad in x-direction y_H , y_L : Upper and lower bound of a pad in y-direction

WF fit against templates





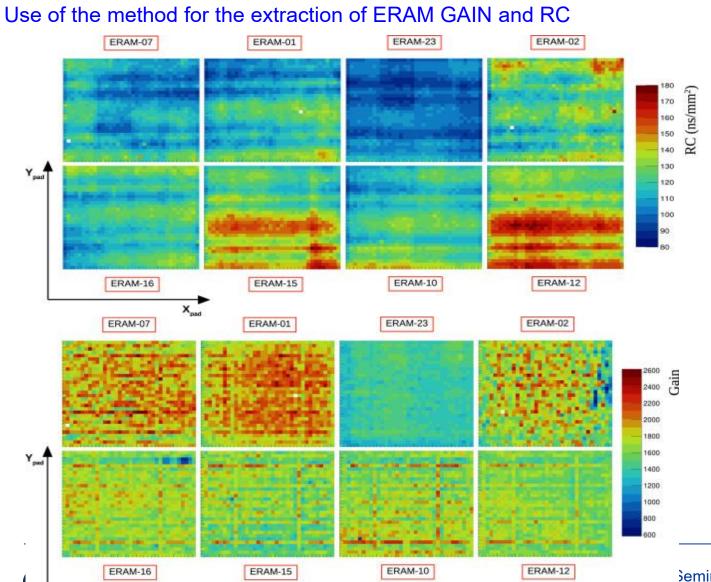








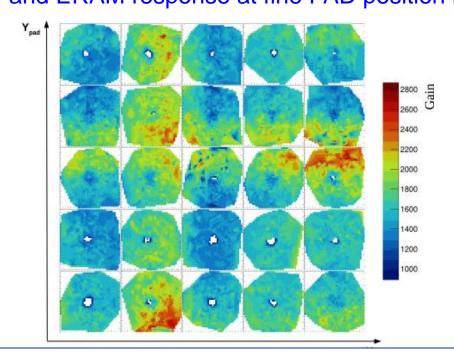
Extraction of RC and Gain maps from X-rays



X-ray conversion position is also fitted

→accurate maps of Gain and RC

Use for detailed studies of charge diffusion and ERAM response at fine PAD position level



Indications are that the **lower resistivity** the **better performances** (eg space resolution)

Reconstructing Q along tracks

For the reconstruction of the charge along the tracks two methods

- Waveform Sum (WS)
- Crossed Pad (XP)

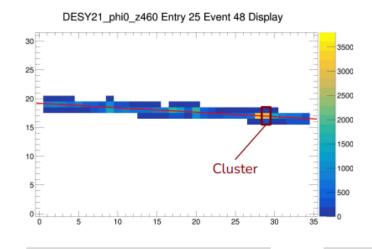
Compare the performance of the two methods for dE/dx extraction



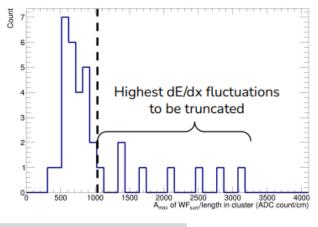


Reconstructing Q along tracks: Waveform Sum

Simple method based on Sum of waveforms(t) (WS) over pads in a cluster



Q missing for inclinded tracks dE/dx estimate in each cluster of Entry 25



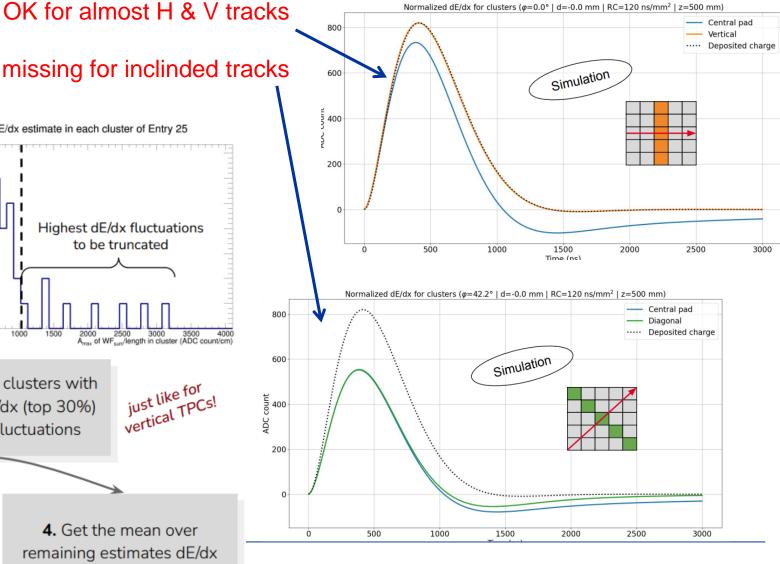
1. Clusterize the pads into slices and sum the waveforms in each slice to get dE

3. Truncate the clusters with the highest dE/dx (top 30%) to get rid of fluctuations

just like for vertical TPCs!

2. Get the track length in each cluster to get dx

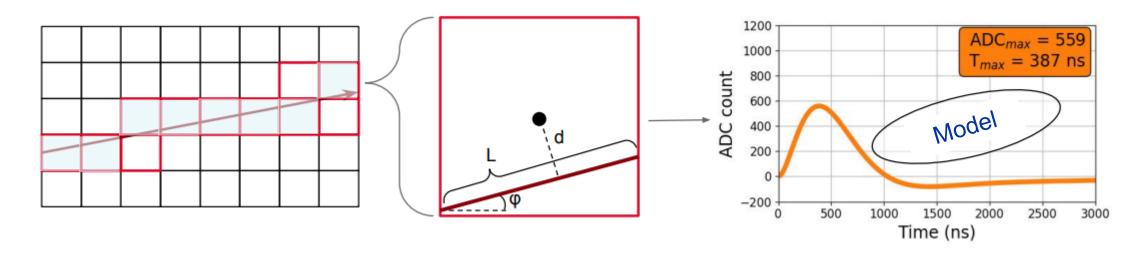
4. Get the mean over remaining estimates dE/dx



Reconstructing Q along tracks: Crossed Pad (XP)

- 1) Reconstruct tracks and consider only pads crossed (XP) by the track (primary pads)
- 2) Reconstruct original (ion induced) charge (Q) for each XP (given the track parameters there) by $Q = A \times (Q/A)$ where A is recorded amplitude on XP and rescaling ratio (Q/A) from Look Up tables (LUT)

LUTs build from model: original Q is distributed linearly over the segment for each XP so that solutions of 1D diffusion equations can be used



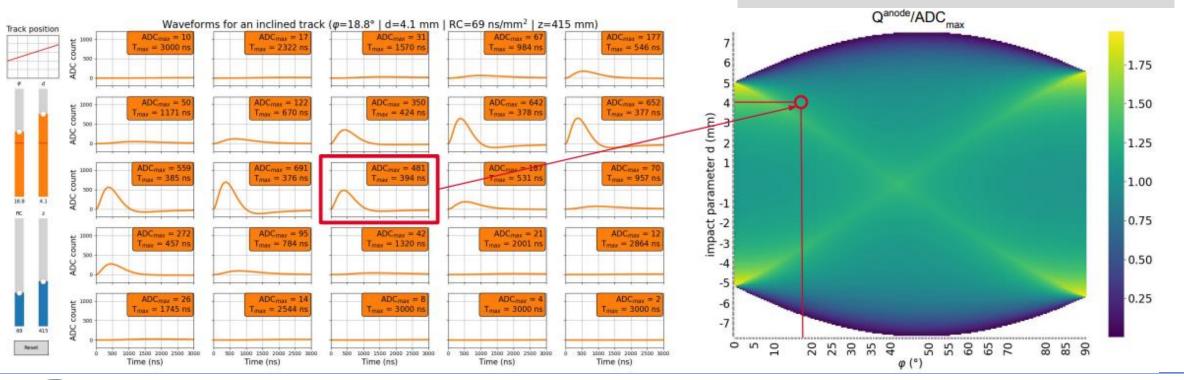
- 1) No clustering => potentially more accurate method because reconstructing full induced charge on primary pads
- 2) «dilution of ion signal» on a XP pad, due to charge spread over the pad is correctly taken into account
- 3) «longitudinal correlation» among adjacent XP pads, due to charge spread along track direction is accounted for
- 4) Fast method though based on model templates (long time is to generate LUTs ...)

Reconstructing Q along tracks: Crossed Pad (XP)

Building the rescaling ratio Q/A ratio 4D LUTs via model

4D Look-Up Table (**LUT**):

- Angle φ: 200 steps [0°, 90°]
- Impact parameter: 200 steps [-7.3, +7.3] mm
- Drift distance: 21 steps [0, 1] m
- RC: 21 steps [50, 150] ns/mm²



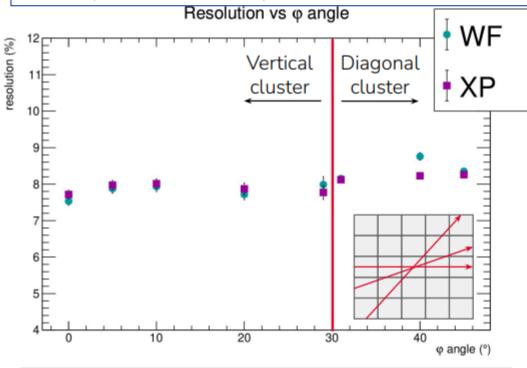


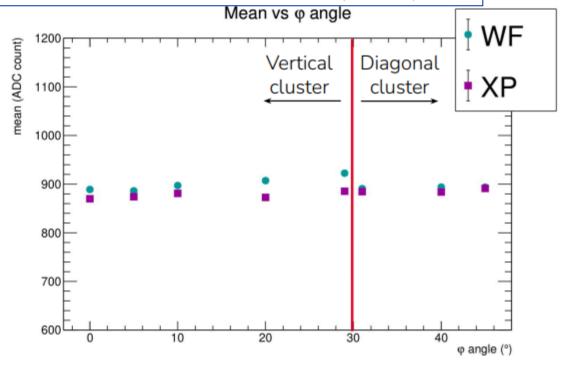


17.07.2023

dE/dx preliminary results: (WS) and (XP) methods

dE/dx (4GeV electrons) – comparison of WF and XP methods on Test Beam data (DESY)

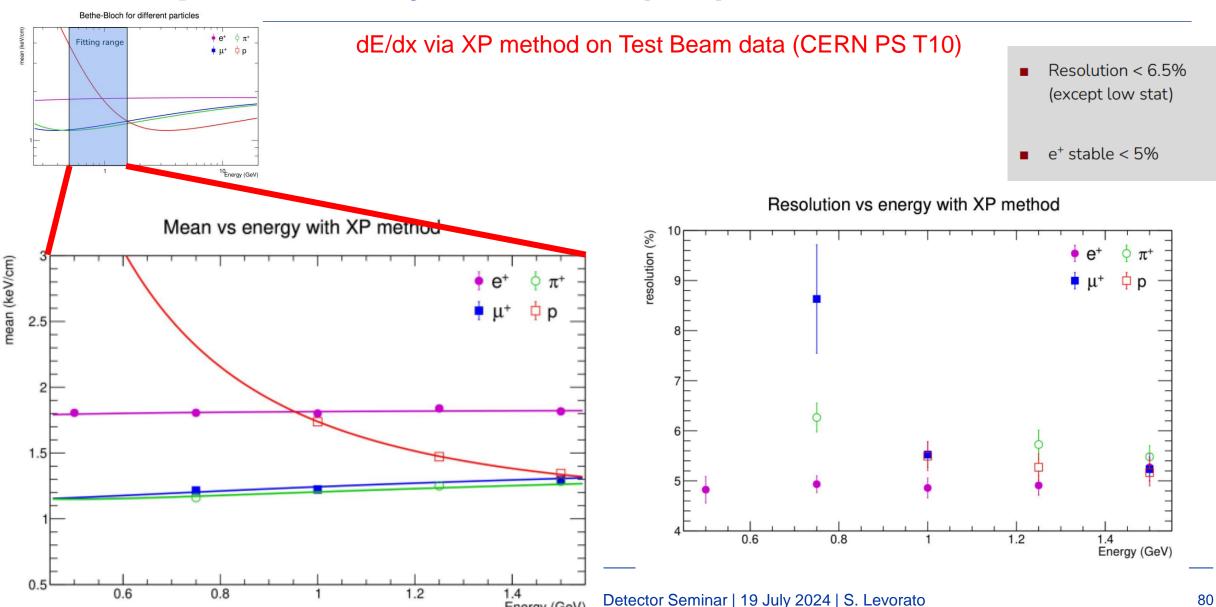




- Resolution $\sigma/\mu \sim 8\%$ and stable
- XP gives better results at diagonal angle

- Flat distribution of dE/dx across φ for XP
- Slight sink with WF_{sum} for diagonal clusters

dE/dx preliminary results: (XP) method

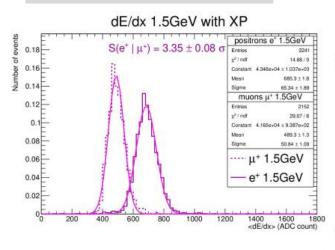


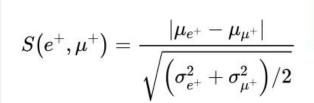
Energy (GeV)

PID preliminary results (XP) vs (WS)

e/μ separation @ 1.5 GeV – Test Beam data (CERN PS T10)

Short tracks (~40cm)

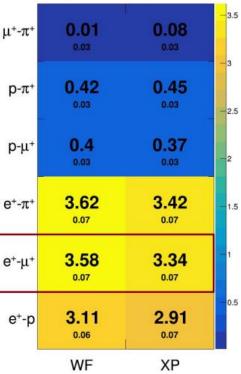




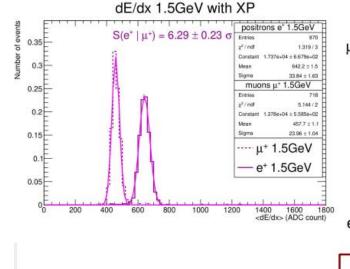
 \blacksquare μ^+ & e^+ split by more than 3σ

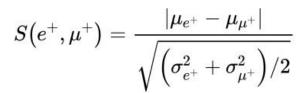
17.07.2023

Separation power



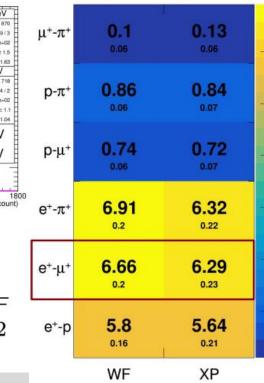
Long tracks (~160cm)





 \blacksquare μ^+ & e⁺ split by more than 6σ

Separation power





Reconstructing tracks

For the reconstruction of the tracks

Log(Q) methods

Full Waveform fit Method



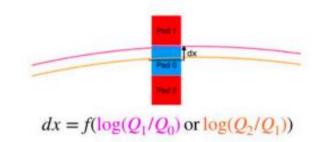


Reconstructing tracks: trajectory fitting

LogQ Method based on clustering & Log[Qprimary /Qsecondary]

- logQ method to reconstruct position in each cluster
- Helix fit performed on those reconstructed positions





Full Waveform fit Method – based on model & no clustering

- 1) Use all the pads associated to a track (Qmax values) to define a (v,u) local frame
- 2) Distribute "arbitrary" point charges along v axis separated by Δv (5mm) the Q per each point is a free parameter
- 3) Diffusion model to predict the waveform generated by point charges in surrounding pads
- 4) Move all points along the u axis to minimize the chi-square difference between measured waveforms and templates

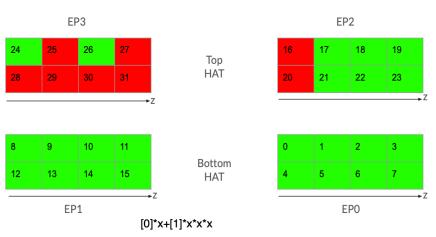
RungeKutta method to fit (u0, du/dv, q/p, t₀, dv/dt)

$$\chi^{2} = \sum_{i(pad)} \sum_{j(timebin)} \frac{(Q_{i,j}^{obs} - Q_{i,j}^{Dixit})^{2}}{\sigma_{i,j}^{2}}$$

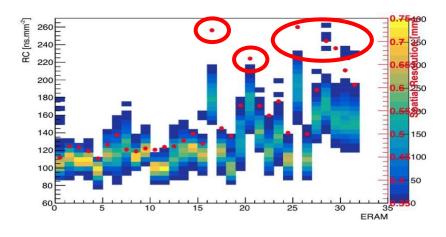


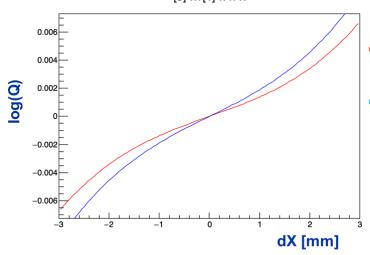
Spatial resolution: HATPC Top and Bottom

Top HAT was equipped with ERAMs with larger RC variation w.r.t. Bottom



17.07.2023





High RC → less charge spreading "flatter curve"

Low RC → more charge spreading "steeper curve"

dX: distance from the center of the cluster and the real position

Non negligible RC variation among the same Endplate of the TPC

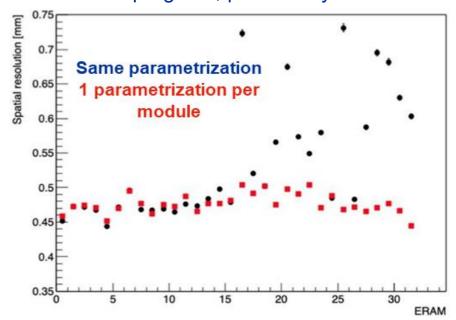
Instead of using one parametrization of the log(Q), ERAM dependent





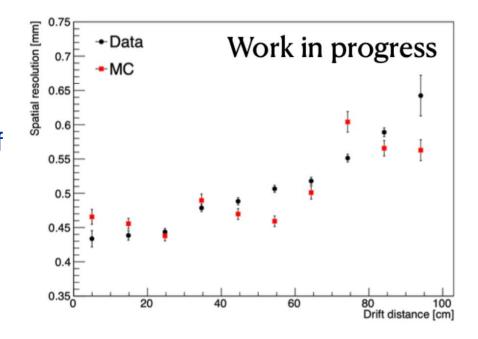
Spatial resolution after reparameterization

Work in progress, preliminary



With the new parametrization all modules have similar performances in terms of spatial resolution

 $\sigma \approx 0.45 \text{ mm}$





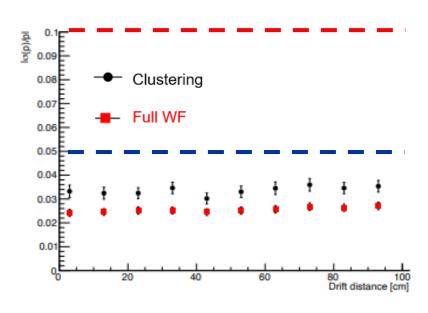
Reconstructing tracks: momentum resolution

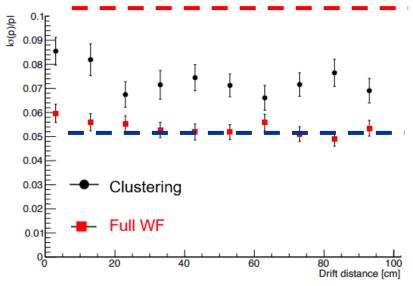
 $\sigma_{\rm p}$ /p momentum resolution as a function of track drift distance: simulated 700 MeV/c muons

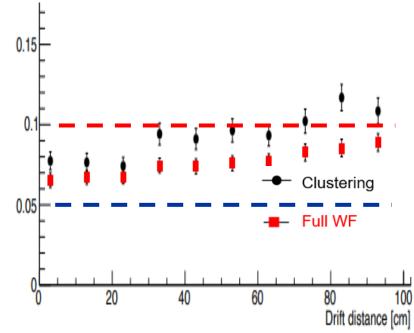
$$\phi = 5.7^{\circ}$$

$$\phi = 45^{\circ}$$

$$\phi = 84.3^{\circ}$$



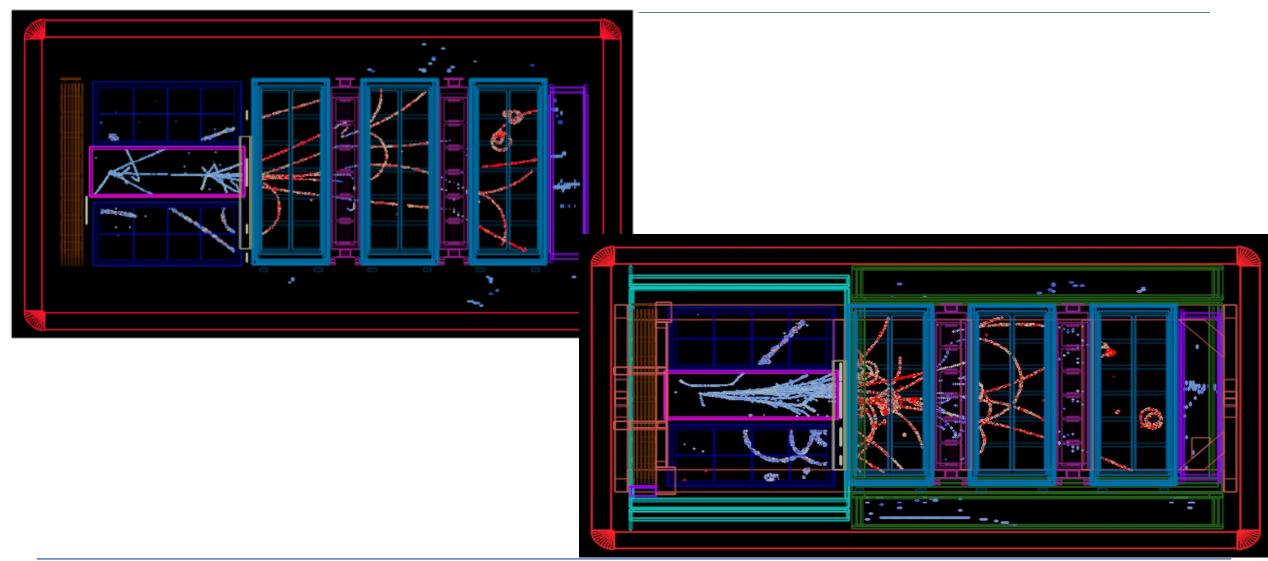






17.07.2023

Event display, full ND280 detector!







Conclusions

Two new TPCs have been just installed in ND280 at JPARC

- Very stable operations in commissioning and technical runs
- Firs Neutrino Data taking just completed, restarting in October 2024

Field cages

- High ratio active/passive volume
- Highly effective insulation & E field uniformity
- Composite material technology exploited at the limit of the technology

Resistive MM with encapsulated anode

- Low resistivity & optimal charge spread & no sparks effects
- Series production allowed several detailed studies
- The ERAM technology is complex and delicate to produce as are all the resistive MPGDs. The
 expertise and excellent partnership with the CERN/PCB workshop enabled a high yield (~80%)
 of high-quality production
- New algorithms for square pads exploiting detailed response model under development





Conclusions

Two new TPCs have been just installed in ND280 at JPARC

- Very stable operations in commissioning and technical runs
- Firs Neutrino Data taking just completed, restarting in October 2024

Field cages

- High ratio active/passive volume
- Highly effective insulation & E field uniformity
- Composite material technology exploited at the limit of the technology

Thanks.

Resistive MM with encapsulated anode

- Low resistivity & optimal charge spread & no sparks effects
- Series production allowed several detailed studies
- The ERAM technology is complex and delicate to produce as are all the resistive MPGDs. The expertise and excellent partnership with the CERN/PCB workshop enabled a high yield (~80%) of high-quality production
- New algorithms for square pads exploiting detailed response model under development





Thanks to CERN

CERN

We would like to express our gratitude for the continuous and extremely valuable support from CERN

Burkard Schmidt, Roberto Guida, Frederic Merlet and colleagues → Gas system EP-DT/ED-DT-FS

Davide Tommasini, Roland Piccin, Sebastien Clement, Cedric Urscheler → Polymer lab/TE-MSC

Rui de Olivera, Olivier Pizzirusso→ EP-DT-EF

Eraldo Oliveri, Djunes Janssen→ EP-DT-DD

Francesco Lanni, Lluis Secundino Miralles Verge Albert DE ROECK, Filippo Resnati → Neutrino Platform

Ahmed Cherif, Jean Philipphe Rigaudt → Metrology/TE-MSC-SMT

Antje BEHRENS, Jean Christophe Gayde → BE-GM-ESA

17.07.2023

Mauro Taborelli, Colette Charvet, Marcel Himmerlich → TE-VSC-SCC

Paolo Chiggiato → TE-VSC

Patrick Muffat, Loredana ZENI Toberer, Laurence Planque, Stephanie Krattinger, Elsa Clerc→ SCE-SSC-LS





Thanks to CERN

CERN

We would like to express our gratitude for the continuous and extremely valuable support from CERN

Burkard Schmidt, Roberto Guida, Frederic Merlet and colleagues → Gas system EP-DT/ED-DT-FS

Davide Tommasini, Roland Piccin, Sebastien Clement, Cedric Urscheler → Polymer lab/TE-MSC

Rui de Olivera, Olivier Pizzirusso→ EP-DT-EF

Eraldo Oliveri, Djunes Janssen→ EP-DT-DD

Francesco Lanni, Lluis Secundino Miralles Verge Albert DE ROECK, Filippo Resnati → Neutrino Platform

Ahmed Cherif, Jean Philipphe Rigaudt → Metrology/TE-MSC-SMT

Antje BEHRENS, Jean Christophe Gayde → BE-GM-ESA

Mauro Taborelli, Colette Charvet, Marcel Himmerlich → TE-VSC-SCC

Paolo Chiggiato → TE-VSC

Patrick Muffat, Loredana ZENI Toberer, Laurence Planque, Stephanie Krattinger, Elsa Clerc→ SCE-SSC-LS

Thanks to INFN support at CERN and the CEA ANTENNA colleagues





Spare

Just in Case



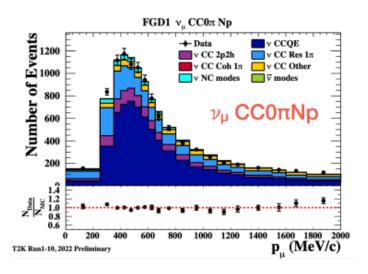




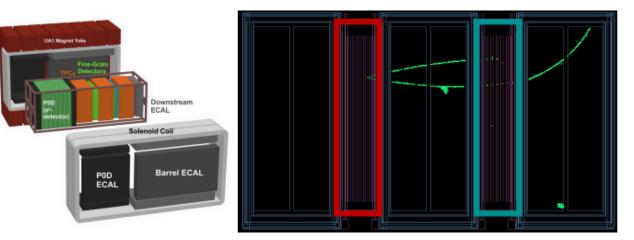


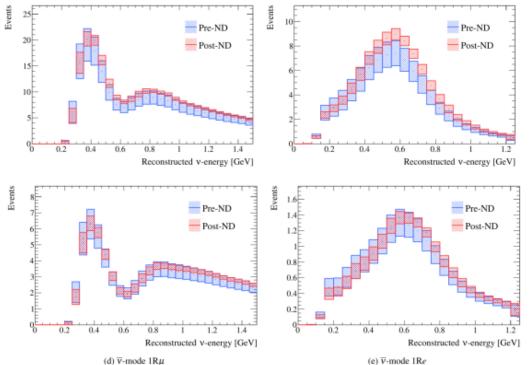
Near Detector impact on Oscillation Analysis

- ND280 magnetized detector
- Select interactions in FGD and measure muon kinematics in the TPCs
- Separate samples based on number of reconstructed pions (CC0π, CC1π, CCNπ), protons, photons, etc
- Factor of ~3 reduction on the uncertainty on the event rates at the Far Detector

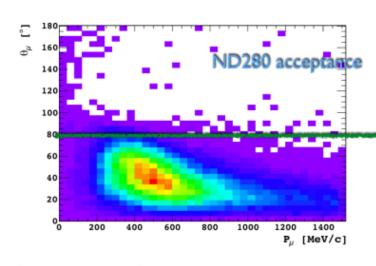


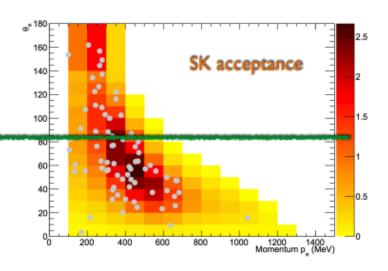
	Pre-	Post-	
	ND FIT	ND FIT	
Sample	error	error	
FHC 1Rμ	11.1%	3.0%	
RHC $1R\mu$	11.3%	4.0%	
FHC 1Re	13.0%	4.7 %	
RHC 1Re	12.1%	5.9%	
FHC 1Re 1d.e.	18.7%	14.3%	

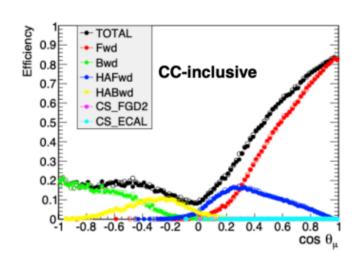




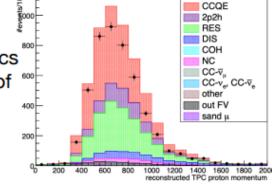
ND280 limitations







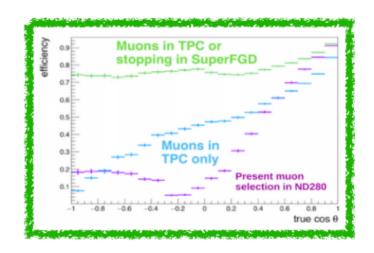
- Improve angular acceptance ν
- Better reconstruction and usage of the hadronic part of the interactions!
 - Currently samples are selected according to their topology (0π, 1π, 1p, Nπ, ...) but the kinematics
 of the hadrons is not used in any way in the constraint on flux and x-sec systematics → plenty of
 additional information to be exploited
 - This is due to both, a low efficiency from ND280 to reconstruct hadrons and the difficulties in modeling the x-sec systematics for the hadronic part

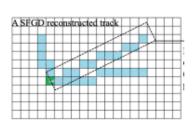


• With the upgrade we plan to improve the efficiency to reconstruct hadronic part



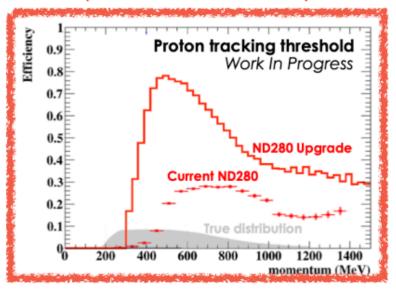
ND280 Upgrade improvements

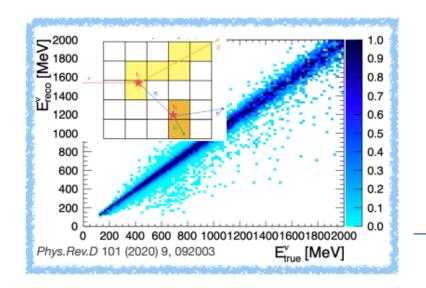




- High-Angle TPCs allow to reconstruct muons at any angle with respect to beam
- Super-FGD allow to fully reconstruct in 3D the tracks issued by ν interactions →lower threshold and excellent resolution to reconstruct protons at any angle
 - Improved PID performances thanks to the high granularity and light yield
- Neutrons will also be reconstructed by using time of flight between vertex of $\bar{\nu}$ interaction and the neutron re-interaction in the detector

Protons → threshold down to 300 MeV/c (>500/c MeV with current ND280)







Mantle resistance

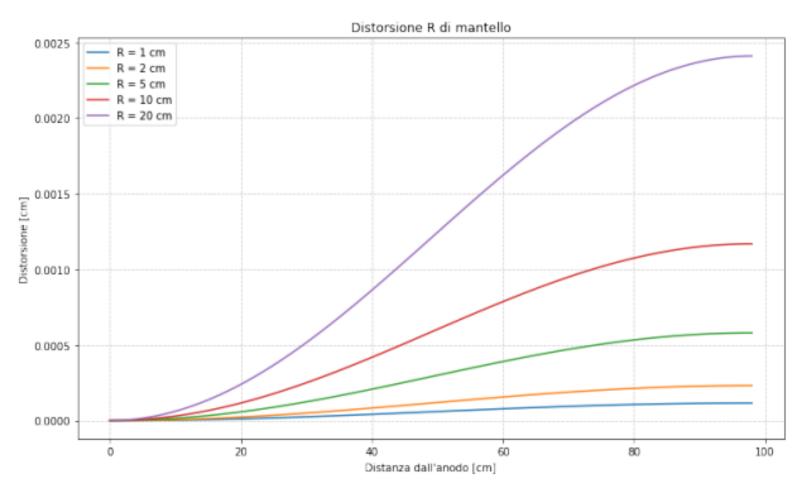


Figura 4.2: Spostamento lungo R del punto di arrivo di un elettrone causato da una resistenza R_{man} di un mantello isolante mille volte il valore della catena di resistori R. La distorsione é mostrata come funzione del punto di partenza z (Distanza dall'anodo).

ERAM Production - about 50 detectors

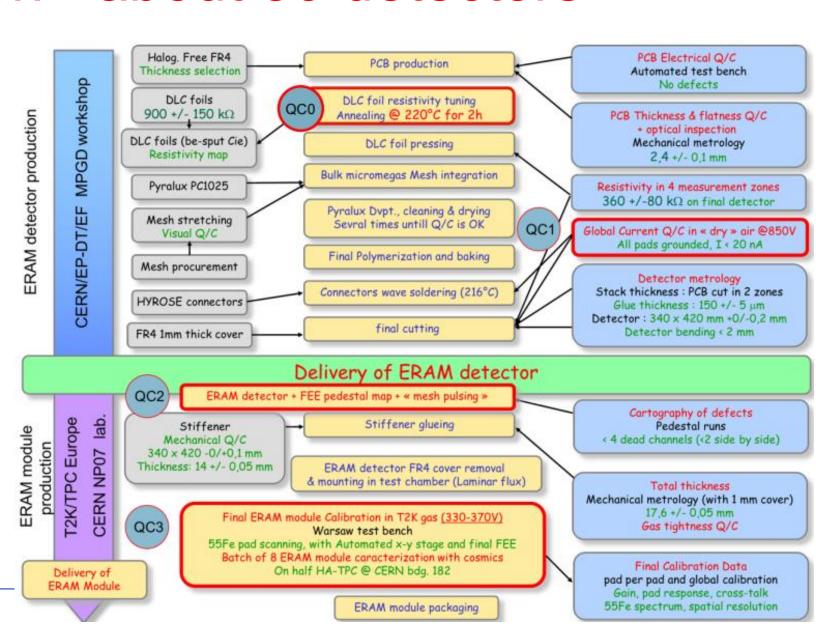
Crucial steps in production (needed tuning)

- 1) Selecting DLC foil resistivity
- Large variations from DLC provider
- Value stable after annealing
- 2) Gluing steps by Pressing
- DLC to PCB
- Stiffener to DLC-PCB

X-rays Test Bench at CERN was fundamental to

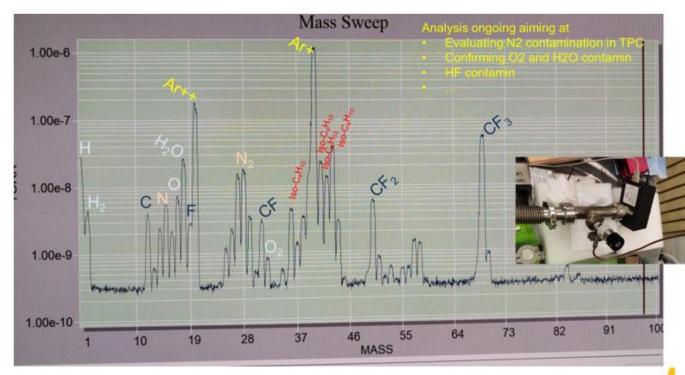
- 1) Qualify, characterize and calibrate all prototypes and series ERAMs
- 2) support the development of detailed ERAM response model





Field Cage assembling, characterization at CERN

Gas contamination from Field Cage – other contaminants



Main componensts → multi-peaks consistent with ratios found in literature

- H2O (+ HO) contamination 2% → consistent with other sensors (Vaisala)
- O2 peak below sensitivity → consistent with ppm level → need further checks

Analysis of gas composition during cosmics test in May

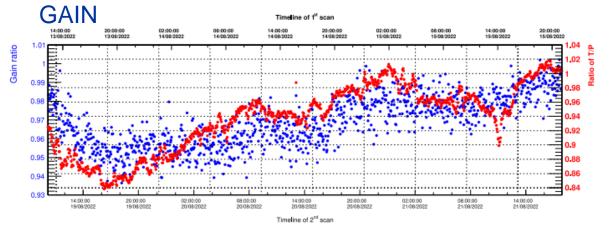
More accurate estimates ongoing

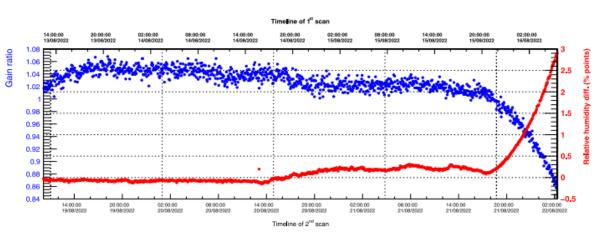
- N2 analysis
- HCl acid
- Evolution in time of components

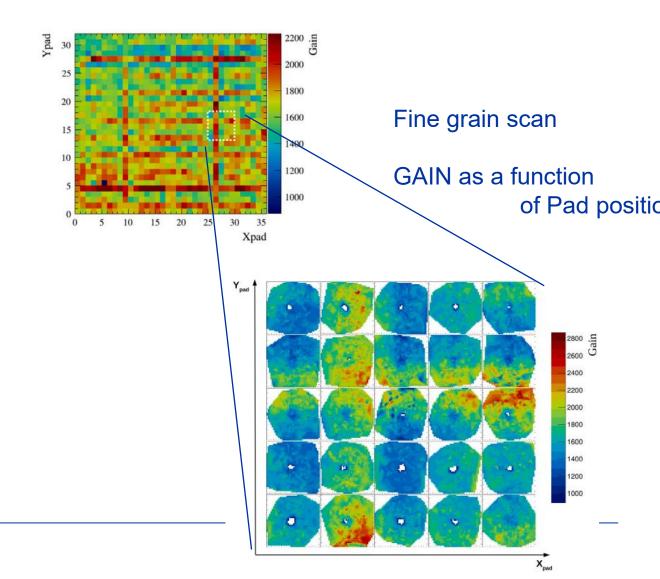


ERAM Series Production experience

Effect of gas density on (gas)





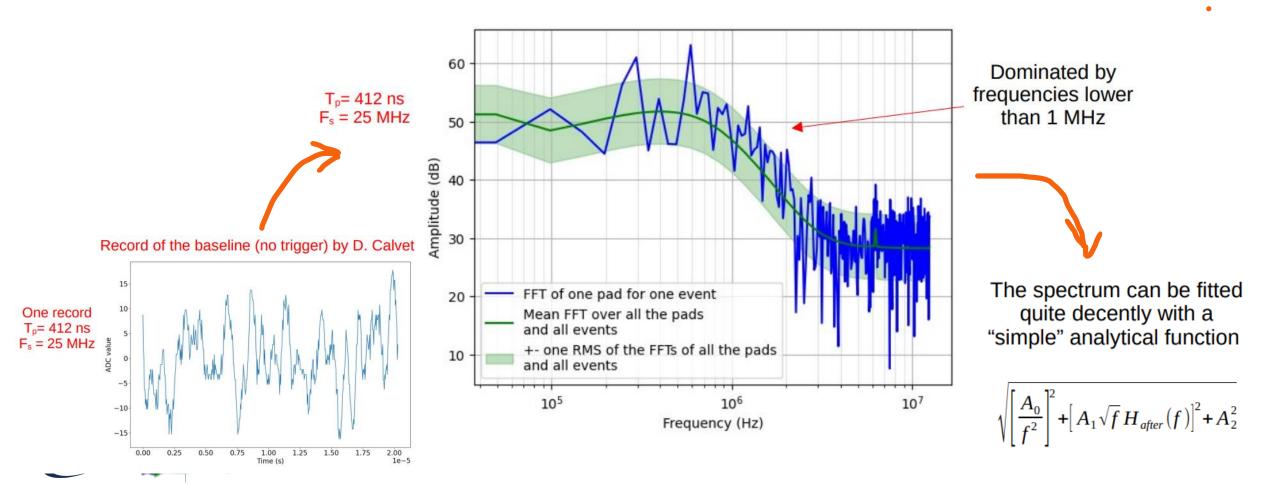




Effect of humidity on (gas) GAIN

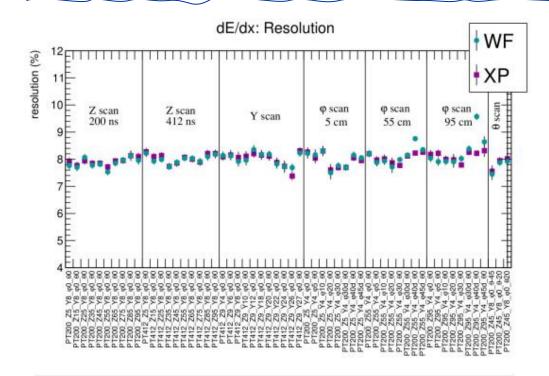
ERAM detector response - Simulation

Use of the model for Simulation of charge deposition in events Where additional ingredient is noise detailed modeled

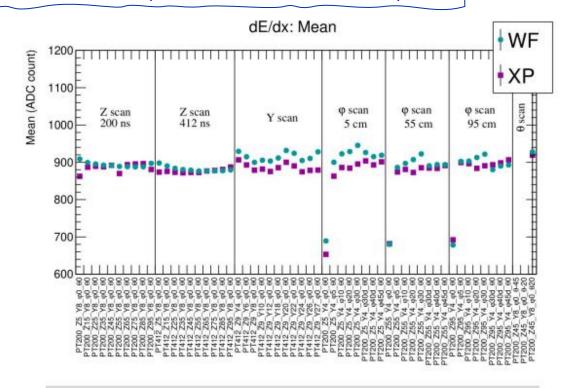


Reconstructing tracks dE/dx

dE/dx – comparison of SWF and XP methods on Test Beam data (4GeV electrons, DESY)

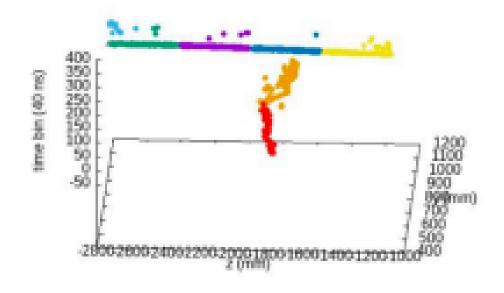


- Very good agreement overall
- Better resolution with XP with diagonal tracks



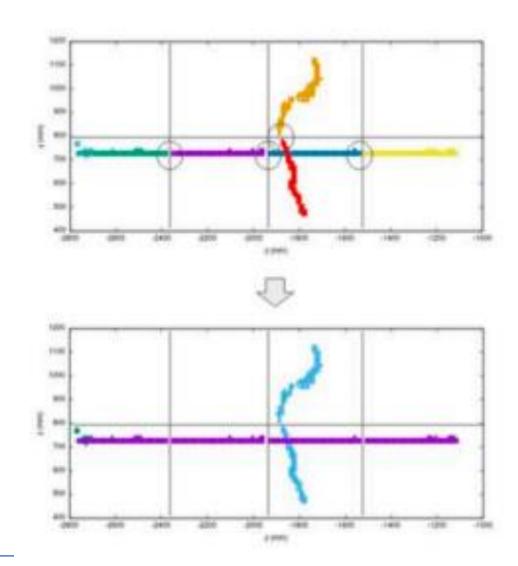
- Disagreement at small drift distance: reflects the track fitting quality
- Disagreement for Y scan: taken at small drift distance
- Disagreement for diagonal tracks: using only on correction function for WF_{sum} is not suitable

Reconstructing tracks – pattern recognition



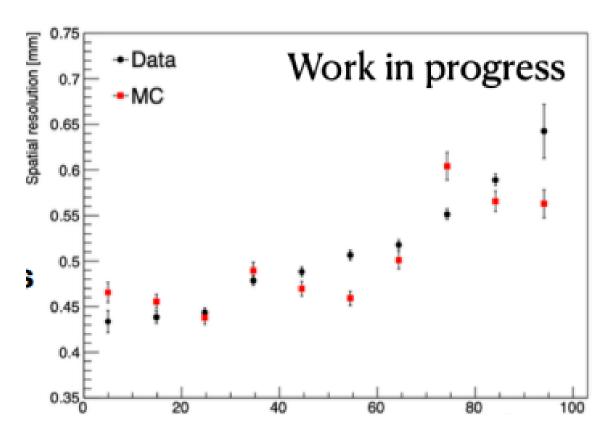


- Waveform multipeak search in order to differentiate vertices and crossing trajectories
- Merging between different ERAMs and End Plates

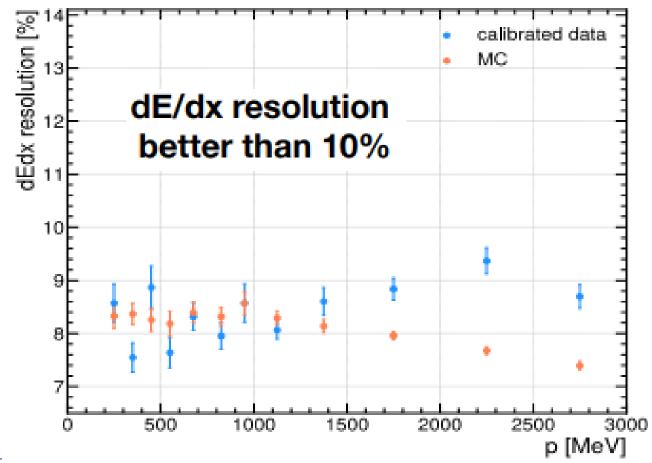




Reconstructing tracks - trajectory fitting

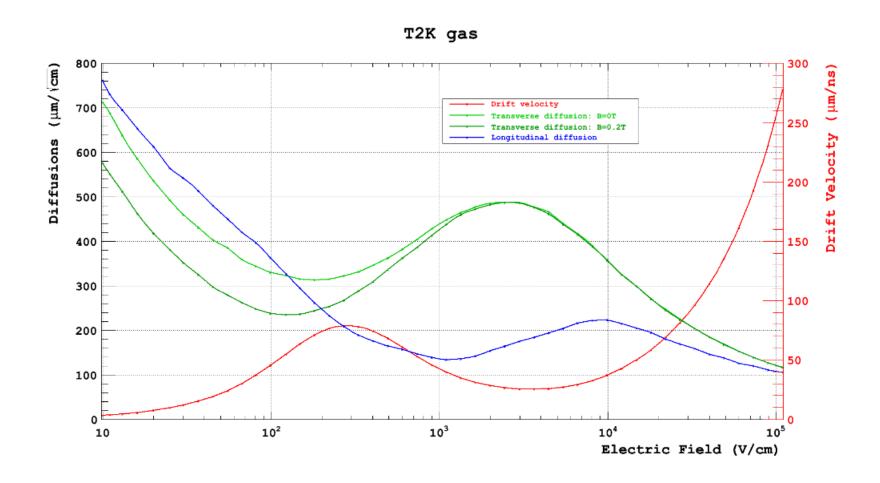


Spatial resolution ~500 µm with muons





T2K gas properties







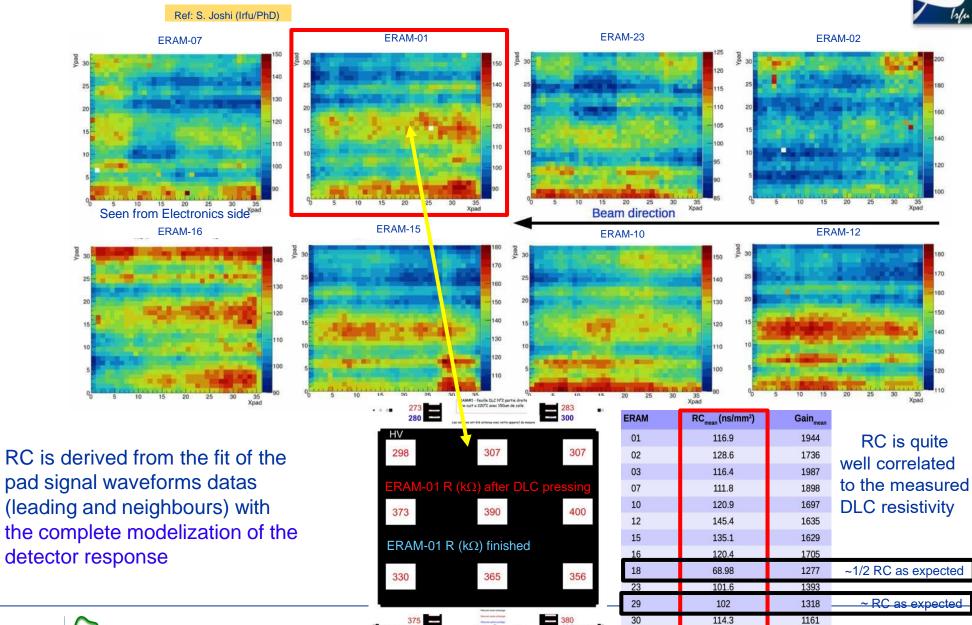






Figure 31: A map of gain non-uniformit shift of the mean amplitude reconstruct pad under study with respect to the me

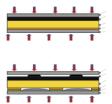


Figure 32: Schematic view of the DLC resulting in the non-uniformities observed. The arrows represent the mechanical of when the soldermask is removed and re-

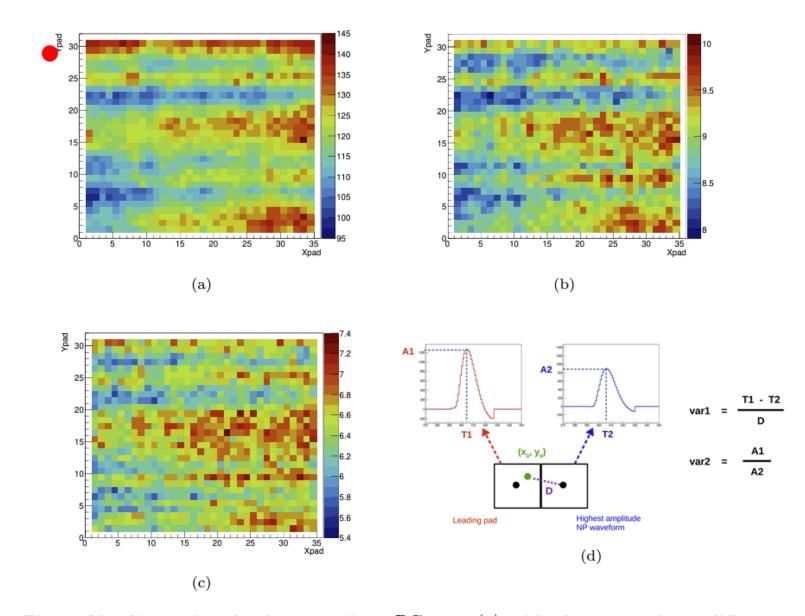


Figure 23: Comparing the features of an RC map (a) with the maps of two different basic-level variables (b) and (c) for ERAM-16. Variables var1 and var2 described in plot (d) are used to construct the maps (b) and (c) respectively.



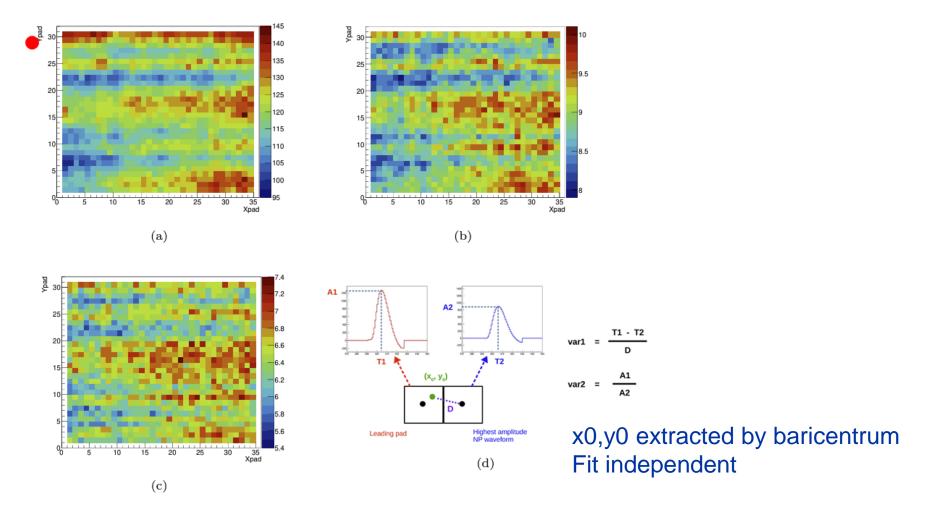


Figure 23: Comparing the features of an RC map (a) with the maps of two different basic-level variables (b) and (c) for ERAM-16. Variables var1 and var2 described in plot (d) are used to construct the maps (b) and (c) respectively.



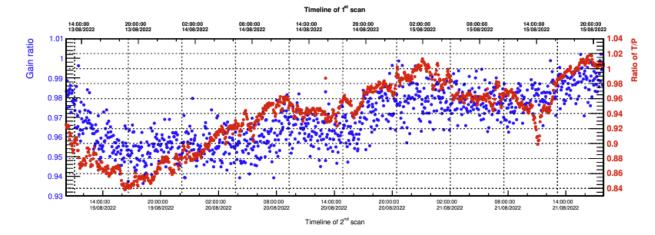


Figure 35: Effect of T/P on gain of an ERAM. The top and bottom x-axes represent the timelines of the two full detector scans.

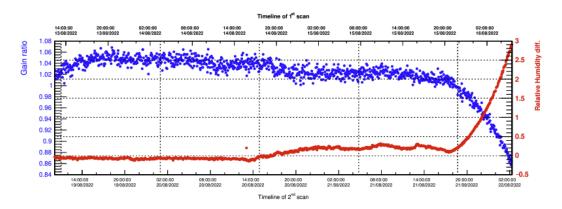


Figure 36: Effect of relative humidity on gain of an ERAM. The top and bottom x-axes represent the timelines of the two full detector scans.



7/19/2024

Table 7. Typical Electrical Properties of Kapton® Type HN and HPP-ST Films

Property Film Gauge	Typical V	/alue	Test Condition	Test Method
Dielectric Strength	V/μm (kV/mm)	(V/mil)		
25 μm (1 mil)	303	(7700)	60 Hz	
50 μm (2 mil)	240	(6100)	1/4 in electrodes	ASTM D-149
75 μm (3 mil)	201	(5,100)	500 V/sec rise	
125 μm (5 mil)	154	(3900)		
Dielectric Constant				
25 μm (1 mil)	3.4	3.4		
50 μm (2 mil)	3.4	3.4		ASTM D-150
75 μm (3 mil)	3.5	3.5		
125 μm (5 mil)	3.5	3.5		
Dissipation Factor				
25 μm (1 mil)	0.001	0.0018		
50 μm (2 mil)	0.002	0.0020		ASTM D-150
75 μm (3 mil)	0.002	0.0020		
125 μm (5 mil)	0.002	0.0026		
Volume Resistivity	Ω•cn	1		
25 μm (1 mil)	1.5×1	1.5×10^{17}		
50 μm (2 mil)	1.5×1	1.5×10^{17}		ASTM D-257
75 μm (3 mil)	1.4×1	0^{17}		
125 μm (5 mil)	1.0×1	0^{17}		



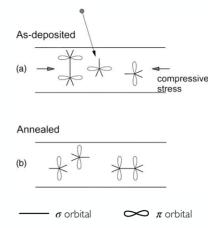


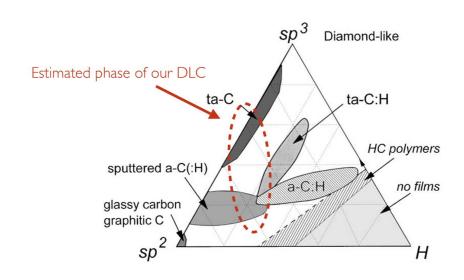
7/19/2024

Although a-C:H and ta-C belong to the same material family, they are not produced by the same coating process. a-C:H is achieved by PECVD (Plasma Enhanced Chemical Vapor deposition) in a gaseous environment. Whereas ta-C is produced by PVD-arc (Physical Vapor deposition arc) from a solid carbon target. PVD-arc technology enables the production of a ta-C coating with a higher percentage of sp3 hybridization without hydrogen and providing a higher hardness.

· Thermal annealing of ta-C is well known

- a-C:H as well. But.
- "Thermal annealing of a-C:H also reduces the stress, as in ta-C. However, as the bonding in a-C:H is less stable during annealing, annealing is less useful in this case."
- Mechanism described
 - Thermal annealing converts a small fraction of sp³ (2%) to sp²
 - Distance between atoms is different between sp² and sp³
 - New sp² structure has aligned electron orbitals
 - The conversion causes exponential decrease in resistivity
 - Compressive stress relieved by new sp² structure with electron orbitals aligned





Kensuke Yamamoto^A

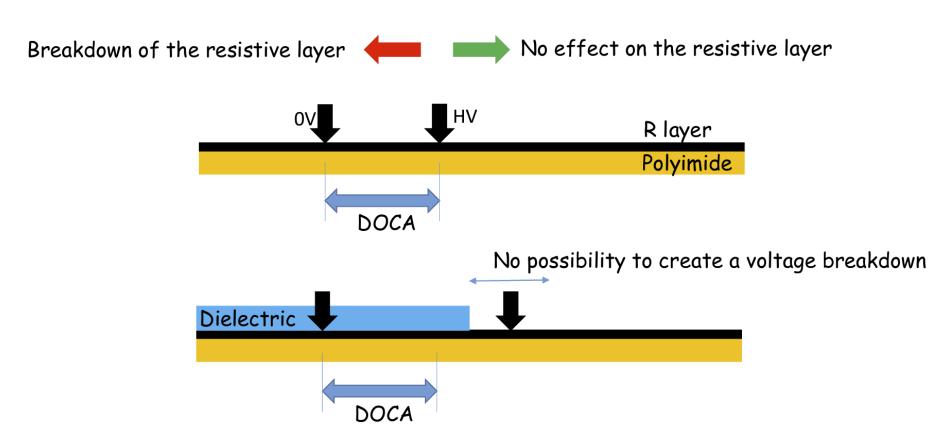
S. Ban^A, W. Li^A, A. Ochi^B, W. Ootani^A, A. Oya^A, H. Suzuki^B, M. Takahashi^B

(AThe University of Tokyo, BKobe University)



7/19/2024 111/20

DOCA(Distance Of Closest Approach)



A breakdown of the resistive layer means creating a low Ohmic channel in the layer

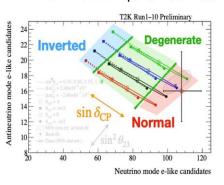


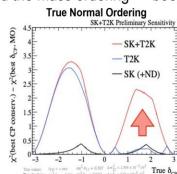


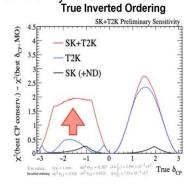


T2K+SK joint analysis

- T2K has good sensitivity to δ_{CP} but mild sensitivity to mass ordering
- SK has good constraint on mass ordering but not on δ_{CP}
- Adding SK atmospheric sample allows to break the degeneracies between the CP violation parameter δ_{CP} and the mass ordering \rightarrow boost sensitivity to CP



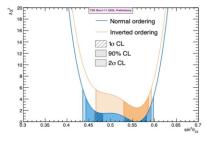


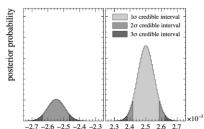


Mass ordering and θ_{23} octant

- Slight preference for normal ordering and upper octant but none of them is significative
 - Bayes factor NO/IO = 3.3
 - Bayes factor $(\theta_{23}>0.5)/(\theta_{23}<0.5) = 2.6$

	$\sin^2\theta_{23} < 0.5$	$\sin^2\theta_{23} > 0.5$	Sum
NH $(\Delta m_{32}^2 > 0)$	0.23	0.54	0.77
IH $(\Delta m_{32}^2 < 0)$	0.05	0.18	0.23
Sum	0.28	0.72	1.00





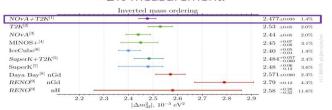
Both experiments individually prefer normal ordering and $\delta CP \sim \pi/2$, T2K prefers upper octant, SK prefer lower octant

We performed Bayesian and Frequentist analyses → frequentist analyses shown today

The CP-conserving value of the Jarlskog invariant is excluded with a significance between 1.9 and 2 σ

NOvA-T2K joint fit: takeaways

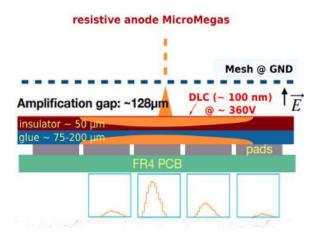
Advancing the precision frontier on $|\Delta m^2_{32}|$ <2% measurement!

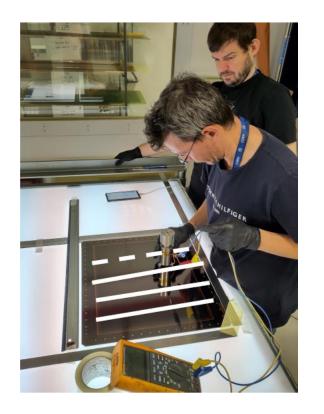


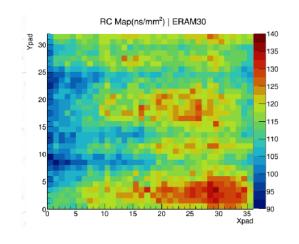
Mild preference for Inverted Ordering but influenced by θ_{13} constraint

NOVA+T2K only IO (71%) IO (57%) NOVA+T2K $+ 1D \theta_{13} + 2D (\theta_{13}, \Delta m^2_{32})$ NO (59%)

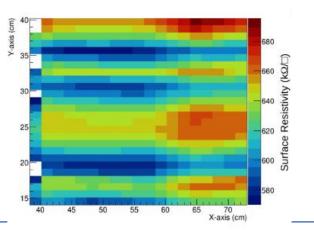
- NOvA & T2K's first joint results:
 - Yield strong constraint on ∆m²₃₂
 - Weakly prefer IO or NO depending on which reactor constraint is applied
 - Strongly favor CP violation in Inverted Ordering
- Collaborations in active discussion about joint fit next steps







And this matches
the resistivity direct
measurement (C is
very well
constrained by the
thickness of
insulator)



R inhomogenities in the sputtering are clearly visible in the direction perpendicular to the drum rotation axis.



7/19/2024